

# **ER-EPD027-2**

## **E-Paper Display Module Datasheet**





## **EastRising Technology Co., Limited**

#### Attention:

- A. Some specifications of IC are not listed in this datasheet. Please refer to the IC datasheet for more details.
- B. The related documents for interfacing, demo code, IC datasheet are all available, please download from our web.
- C. Please pay more attention to "INSPECTION CRITERIA" in this datasheet. We assume you already agree with these criterions when you place an order with us. No more recommendations.

REV	Description	Release Date
1.0	Preliminary Release	Nov-30-2020



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### 1. ORDERING INFORMATION

#### 1.1 Order Number

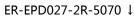
Order Number	Description
ER-EPD027-2B	2.7 inch E-Paper (E-ink) Display White/Black Color
ER-EPD027-2Y	2.7 inch E-Paper (E-ink) Display Yelllow/White/Black Color
ER-EPD027-2R	2.7 inch E-Paper (E-ink) Display Red/White/Black Color
ER-EPD027-2-5070	2.7 inch E-Paper (E-ink) Display with Arduino Shield
ER-EPD027-2-5103	2.7 inch E-Paper (E-ink) Display with Raspberry Pi HAT

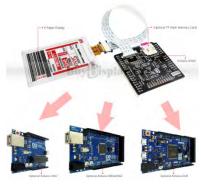
#### 1.2 Image

ER-EPD027-2B ↓ ER-EPD027-2Y ↓ ER-EPD027-2R ↓



ER-EPD027-2B-5070 ↓ ER-EPD027-2Y-5070 ↓





ER-EPD027-2B-5103 ↓ ER-EPD027-2Y-5103 ↓ ER-EPD027-2R-5103 ↓



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### 2. SPECIFICATION

### 2.1 Display Specification

Item	Standard Value	Standard Value				
Display Format	176x264		Pixels			
Display Connector	FFC					
FPC Connector	24 Pin,0.5mm Pitch, SN	MD Horizontal Type Top contact				
	ER-EPD027-2B	0 ~ 50				
Operating Temperature	ER-EPD027-2R	0 ~ 50	℃			
	ER-EPD027-2Y	-EPD027-2Y 0 ~ 50				
	ER-EPD027-2B	-25 ~ 60				
Storage Temperature	ER-EPD027-2R	-25 ~ 60	°C			
	ER-EPD027-2Y	ER-EPD027-2Y -25 ~ 60				
Sunlight Readable	Yes	Yes				

### 2.2 Mechanical Specification

Item	Standard Value	Unit
Screen Size	2.7	inch
Outline Dimension with FPC Folded	45.80(W) x70.42(H)x0.95(T)	mm
Active Area	38.192(W) x57.288(H)	mm
Dot Pitch	0.217x0.217	mm

### 2.3 Electrical Specification

Item	em Standard Value		
IC Package	COG		
Controller	EK79651AB		
Interface	3/4 Wire SPI		

#### 2.4 Optical Specification

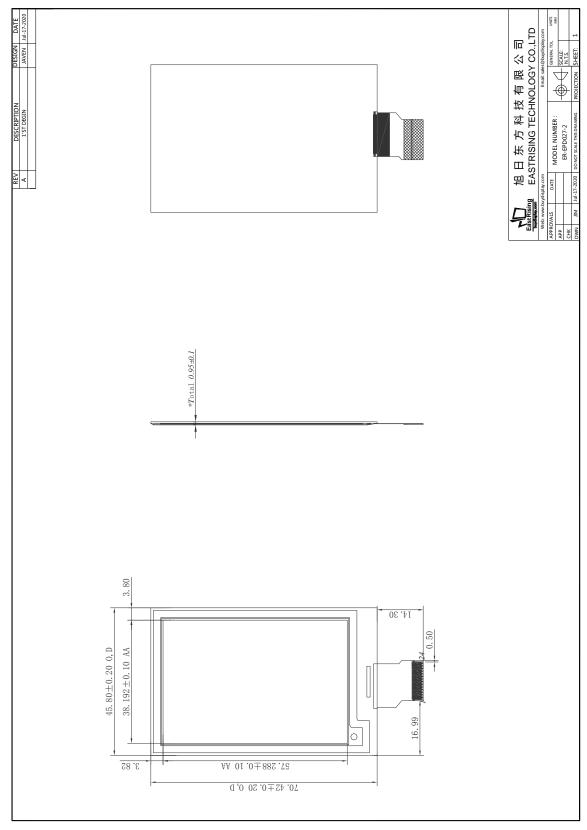
Item	Standard Value	Unit
LCD Type	E-Ink Display (E-Paper Display)	
Viewing Angle Range	Left:85 , Right:85 , Up:85 , Down:85	deg



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### 3. OUTLINE DRAWING

### 3.1 ER-EPD027-2 Outline Drawing





### 4. Input/Output Terminals

Pin#	Single	Description	Remark
1	NC	No connection and do not connect with other NC pins e	Keep Open
2	GDR	N-Channel MOSFET Gate Drive Control	
3	RESE	Current Sense Input for the Control Loop	
4	NC	No connection and do not connect with other NC pins e	Keep Open
5	VSHR	Positive source voltage for Red	
6	TSCL	I2C Interface to digital temperature sensor Clock pin	
7	TSDA	I2C Interface to digital temperature sensor Date pin	
8	BS	Bus selection pin	Note 6-5
9	BUSY N	Busy state output pin	Note 6-4
10	RST N	Reset	Note 6-3
11	DC	Data /Command control pin	Note 6-2
12	CSB	Chip Select input pin	Note 6-1
13	SCL	serial clock pin (SPI)	
14	SDA	serial data pin (SPI)	
15	VDDIO	IO voltage supply	
16	VDD	Digital/Analog power.	
17	VSS	Digital ground	
18	VDD 1.8V	1.8V voltage input &output	
19	VOTP	OTP program power (7.5V)	
20	VSH	Positive Source driving voltage	
21	VGH	Power Supply pin for Positive Gate driving voltage and VSH	
22	VSL	Negative Source driving voltage	
23	VGL	Power Supply pin for Negative Gate driving voltage, VCOM and VSL	
24	VCOM	VCOM driving voltage	

Note 6-1: This pin (CSB) is the chip select input connecting to the MCU. The chip is enabled for MCU communication: only when CSB is pulled LOW.

Note 6-2: This pin (DC) is Data/Command control pin connecting to the MCU. When the pin is pulled HIGH, the data will be interpreted as data. When the pin is pulled LOW, the data will be interpreted as command.

Note 6-3: This pin (RST\_N) is reset signal input. The Reset is active low.

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Note 6-4: This pin (BUSY\_N) is Busy state output pin. When Busy\_N is High the operation of chip should not be interrupted and any commands should not be issued to the module. The driver IC will put Busy\_N pin High when the driver IC is working such as:

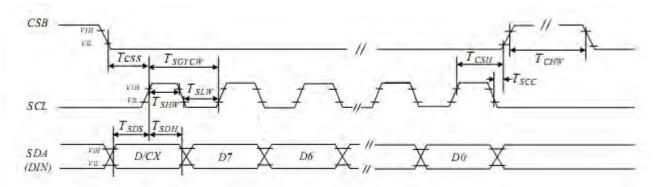
- Outputting display waveform; or
- Communicating with digital temperature sensor

Note 6-5: This pin (BS) is for 3-line SPI or 4-line SPI selection. When it is "Low", 4-line SPI is selected. When it is "High", 3-line SPI (9 bits SPI) is selected.

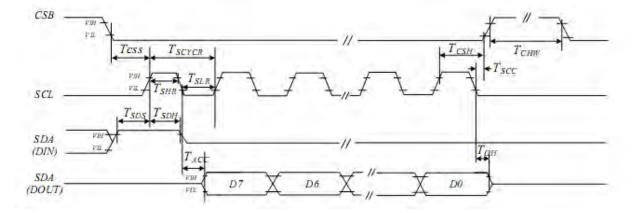
#### 5.SPI COMMAND DESCRIPTION

#### 5.1 "3-Wire" Serial Port Interface

JD79651 use the 3-wire serial port as communication interface for all the function and command setting. 3-Wire communication can be bi-directional controlled by the "R/W" bit in address field. JD79651 3-Wire engine act as a "slave mode" for all the time, and will not issue any command to the 3-Wire bus itself. Under read mode, 3-Wire engine will return the data during "Data phase". The returned data should be latched at the rising edge of SCL by external controller. Data in the "Hi-Z phase" will be ignored by 3-Wire engine during write operation, and should be ignored during read operation also. During read operation, external controller should float SDA pin under "Hi-Z phase" and "Data phase".

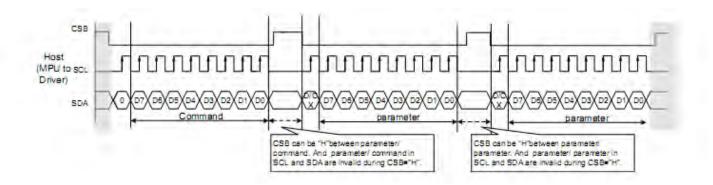


3 pin serial interface characteristics (write mode)

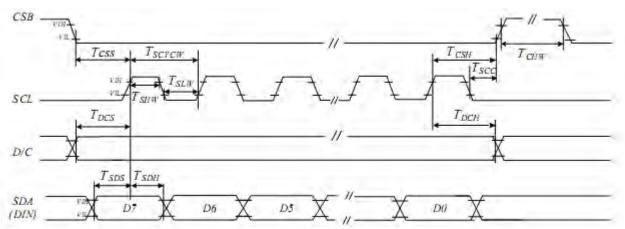


3 pin serial interface characteristics (read mode)

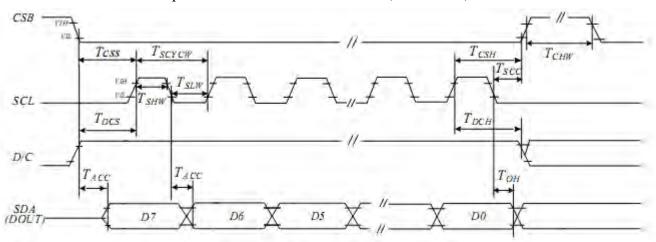




#### 5.2 "4-Wire" Serial Port Interface

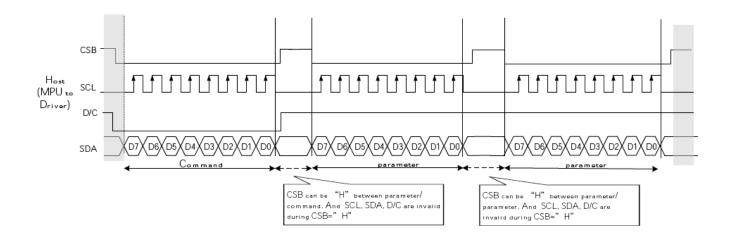


4 pin serial interface characteristics(write mode)



4 pin serial interface characteristics(read mode)





## 6. COMMAND TABLE

#### 6-1Register Table

Following table list all the SPI control registers and bit name definition for EK79686. Refer to the next

section for detail register function description.

ROOH	Address		egister runct		1		Bit						
ROOH	Address	command											Code
ROM	DOOLI	Panel setting	W	0	0	0	0	0	0	0			00H
RO1H	KUUH			1	RES[1]	RES[0]	REG_EN	BWR	UD	SHL			8h
RO1H			W	0	0	0	0	0	0	0			01H
RO1H			W	1	-	-	-	-			EN	EN	03H
ROIH		Dowar catting	W	1			-		-HV	-LV[2]	-LV[1]	-LV[0]	00H
No.   No.	R01H		W	1			VSH [5]		[3]	[2]	[1]	[0]	26H
R02H			W	1			VSL [5]						26H
RO2H   OFF(POF)   W			W	1			VSHR [5]						06H
RO3H   Sequence   Setting(PFS)   W	R02H			0	0	0	0	0	0	0	1	0	02H
R03H		Power off	W	0	0	0	0		0	0	1	0	03H
ROSH   POWER ON   Po	R03H	Sequence Setting(PFS)	W	1	-	-		S_OFF					00H
R05H   Measure (PMES)	R04H	(PON)	W	0	0	0	0	0	0	1	0	0	04H
R06H   Booster Soft   Start (BTST)   W	R05H	Measure	W	0	0	0	0	0	0	1	0	1	05H
R06H   Booster Soft Start (BTST)   W			W	0			0		0	1	1	0	06H
ROOH			W	1			BT_PHA5			HA2			17h
R07H   Deep	R06H		W	1			BT_PHB5						17h
R10H   Sleep(DSLP)			W	1	-		BT_PHC5						17h
R10H   Data Start   W   0   0   0   0   1   0   0   0   1   0   0	R07H							0	0	1	1	1	07H
R10H   transmission   1 (DTM1)   W   1   #   #   #   #   #   #   #   #   #	10711												A5h
R11H   Data Stop (DSP)   R   1   M   M   M   M   M   M   M   M   M	D10H		W	0	0	0	0	1	0	0	0	0	10H
R11H	KIOII												00H
R12H	R11H					0	0	1	0	0	0	1	11H
R12H   Refresh (DRF)	KIIII	` ′	R	1		-	-	-	-	-	-	-	-
R13H	R12H	Refresh	W	0	0	0	0	1	0	0	1	0	12H
Partial Data   W   0   0   0   0   1   0   1   0   0   1   1		Data Start	W	0	0	0	0	1	0	0	1	1	13H
R14H	R13H		W	1	#	#	#	#	#	#	#	#	00h
R14H   transmission   W   1   #   #   #   #   #   #   #   #   00			W	0	0	0	0	1	0	1	0	0	14H
R15H Partial Data W 0 0 0 0 1 0 1 0 1 15 Start transmission 2 (PDTM2) W 1 # # # # # # # # 00	R14H	transmission	W	1	#	#	#	#	#	#	#	#	00h
R15H transmission W 1 # # # # # # # 000 2 (PDTM2)			W	0	0	0	0	1	0	1	0	1	15H
	R15H	transmission	W	1	#	#	#	#	#	#	#	#	00h
Partial   W   0   0   0   1   0   1   1   0   16		Partial	W	0	0	0	0	1	0	1	1	0	16H
R16H Display Refresh(PDR F) W 1 # # # # # # # 00	R16H	Refresh(PDR	W	1	#	#	#	#	#	#	#	#	00h
			W	0	0	0	1	0	0	0	0	0	20H
R20H VCOM	R20H	VCOM											00h
	R21H	White to	W	0	0	0	1	0	0	0	0	1	21H

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	White LUT (LUTWW)	W	1	#	#	#	#	#	#	#	#	00h
R22H	Black to	W	0	0	0	1	0	0	0	1	0	22H
	White LUT (LUTBW/L UTR)	W	1	#	#	#	#	#	#	#	#	00h
R23H	White to	W	0	0	0	1	0	0	0	1	1	23H
	Black LUT (LUTWB/L UTW)	W	1	#	#	#	#	#	#	#	#	00h
R24H	Black to	W	0	0	0	1	0	0	1	0	0	24H
	Black LUT(LUTB B/LUTB)	W	1	#	#	#	#	#	#	#	#	00h
R25H	LUTC option	W	0	0	0	1	0	0	1	0	1	25H
		W	1							XON [9:	:8]	00h
		W	1	XON [7:0]								00h
		W	1							VCOME	I[9:8]	00h
		W	1	VCOMH[7				,				00h
R26H	Set	W	0	0	0	1	0	0	1	1	0	26H
	Vcom/Red states	W	1	0	0			]	g_sel[1:0	b2w_stg		00h
R30H	OSC control	W	0	0	0	1	1	0	0	0	0	30H
D 4011	(OSC)	W	1	-	1	M[2:0]	1.0		N[2:0]	0		3Ah
R40H	Temperature		0	0 D10/TCI	1 D0/T016	0 De/TC(0)	0 D7/TS	0	D5/TS	0 D4/TS	D3/TS	40H
	Sensor Command	R	1	D10/TS[ 7]	D9/TS[6	D8/TS[8]	D7/TS [7]	D6/TS [9]	[8]	D4/TS [10]	[9]	
	(TSC)	R	1	D2	D1	D0	-	-	-	-	-	
R41H	Temperature	W	0	0	1	0	0	0	0	0	1	41H
	Sensor Calibration (TSE)	W	1	TSE	-	-	-	TO[3]	TO[2]	TO[1]	TO[0]	00h
R42H	Temperature	W	0	0	1	0	0	0	0	1	0	42H
	Sensor Write (TSW)	W	1	WATTR [7]	WATTR [6]	WATTR[5	WATT R[4]	WATT R[3]	WATT R[2]	WATT R[1]	WATT R[0]	00h
		W	1	WMSB[ 7]	WMSB[ 6]	WMSB[5]	WMS B[4]	WMS B[3]	WMS B[2]	WMS B[1]	WMS B[0]	00h
		W	1	WLSB[7	WLSB[6	WLSB[5]	WLSB [4]	WLSB [3]	WLSB [2]	WLSB [1]	WLSB [0]	00h
R43H	Temperature	W	0	0	1	0	0	0	0	1	1	43H
	Sensor Read (TSR)	R	1	RMSB[7	RMSB[6	RMSB[5]	RMSB [4]	RMSB [3]	RMSB [2]	RMSB [1]	RMSB [0]	-
		R	1	RLSB[7]	RLSB[6]	RLSB[5]	RLSB[ 4]	RLSB[	RLSB[ 2]	RLSB[	RLSB[	-
R50H	VCOM and	W	0	0	1	0	1	0	0	0	0	50H
	DATA interval setting (CDI)	W	1	VBD[1]	VBD[0]	DDX[1]	DDX[ 0]	CDI[3]	CDI[2]	CDI[1]	CDI[0]	D7h
R51H	Lower Power	W	0	0	1	0	1	0	0	0	1	51H
	Detection (LPD)	R	1	-	-	-	-	-	-	-	LPD	-
R60H	TCON	W	0	0	1	1	0	0	0	0	0	60H
	setting(TCO N)	W	1	S2G[3]	S2G[2]	S2G[1]-	S2G[0 ]	G2S[3	G2S[2 ]	G2S[1 ]	G2S[0 ]	22h
R61H	Resolution	W	0	0	1	1	0	0	0	0	1	61H
	setting (TRES)	W	1	HRES(7)	HRES(6)	HRES(5)	HRES( 4)	HRES( 3)	-	-	-	00H
		W	1	-	-	-	-	-	-	-	VRES( 8)	00H
		W	1	VRES(7)	VRES(6)	VRES(5)	VRES( 4)	VRES( 3)	VRES( 2)	VRES(	VRES( 0)	00H
R62H	Source & gate start setting	W	0	0	1	1	0	0	0	1	0	62H
		W	1	S_start(7	S_start(6	S_start(5)	S_start (4)	S_start (3)	-	-	-	00H
		W	1				gscan				G_star t [8]	00H
		W	1	G_start (7)	G_start (6)	G_start (5)	G_star t (4)	G_star t (3)	G_star t (2)	G_star t(1)	G_star t (0)	00H
R70H	REVISION	W	0	0	1	1	1	0	0	0	0	70H
	(REV)	R	1	REV[7]	REV[6]	REV[5]	REV[4	REV[3	REV[2	REV[1	REV[0	-

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	<del></del>	В	1 1	DEVILLE	DEV[14]	DEVILLO	DEVI	DEVII	DEVII	DEMO	DEMI	1
		R	1	REV[15]	REV[14]	REV[13]	REV[1 2]	REV[1 1]	REV[1 0]	REV[9	REV[8	-
R71H	Status	W	0	0	1	1	1	0	0	0	1	71H
IX/111	register(FLG	R	1	-	PTL_fla	I2C_ERR	I2C_B	Data_f	PON	POF	BUSY	-
	)	TK .	1		g g	IZC_ERR	USYN	lag	1011	101	_N	
R80H	Auto	W	0	1	0	0	0	0	0	0	0	80H
	Measure	W	1	-	-	AMVT[1]	AMV	XON	AMVS	AMV	AMV	10H
	VcomMeasur						T[0]					
	e											
D0477	Vcom(AMV)	***									_	0.477
R81H	Vcom Value (VV)	W	0	1	0	0	3737543	0	0	0	1	81H
R82H	Vcom_DC	R W	0	1	0	VV[5] 0	VV[4]	VV[3]	VV[2] 0	VV[1]	VV[0] 0	82H
K0211	Setting	W	1	-	-	VCDS[5]	VCDS	VCDS	VCDS	VCDS	VCDS	00H
	register(VDC	**	1	_	_	VCDS[3]	[4]	[3]	[2]	[1]	[0]	0011
	S)						[.]	[0]	[-]	[-]	[~]	
RA0H	Program	W	0	1	0	1	0	0	0	0	0	A0H
	Mode(PGM)	W	1	1	0	1	0	0	1	0	1	A5h
RA1H	Active	W	0	1	0	1	0	0	0	1	0	A1H
	program(AP											
RA2H	G) Read OTP	W	0	1	0	1	0	0	0	1	0	A2H
KA211	Data(ROTP)	R	1	#	#	#	#	#	#	#	#	- A211
RE0H	CASCADE	W	0	1	1	1	0	0	0	0	0	E0H
112011	setting(CCS	W	1	-	-	-	-	Cce-sel	Cce-lr	TSFL	CCEIN	00H
	ET)									X		
RE5H	Force	W	0	1	1	1	0	0	1	0	1	E5H
	Temperature	W	1	TS_SET	TS_SET	TS_SET[5	TS_SE	TS_SE	TS_SE	TS_SE	TS_SE	00h
				[7]	[6]	]	T[4]	T[3]	T[2]	T[1]	T[0]	
RE6H	LVD voltage Select	W	0	1	1	1	0	0	-	LVD_	0 LVD_	E6H 03h
	Select	w	1	-	-	-	-	-	-	SEL0]	SEL[0	USII
										SELO		
											,	
RE7H	Panel Break	W	0	1	1	1	0	0	1	1	1	E7H
	Check	R	1	-	-	-	-	-	-	-	PSTA	-
RE8H	Power saving	W	0	1	1	1	0	1	0	0	0	E8H
		W	1	VCOM_	VCOM_	VCOM_W	VCO	SD_W	SD_W	SD_W	SD_W	00h
				W[3]	W[2]	[1]	M_W[ 0]	[3]	[2]	[1]	[0]	
RE9H	AUTO	W	0	1	1	1	0	1	0	0	1	Е9Н
112711	sequence	W	1	1	0	1	0	0	1	0	1	00h
REFH	Checksum	W	0	1	1	1	0	1	1	1	11	EFH
	program											
	toOTP											
RF0H	Remap LUT	W	0	1	1	1	1	0	0	0	0	F0H
		W	1	-	-	-	Bkup-l	Rmp2-	Rmp2-	Rmp2-	Rmp2-	1Fh
							ut-2-en	table-s el[3]	table-s el[2]	table-s el[1]	table-s el[0]	
		W	1	-	-	-	Bkup-l	Rmp1-	Rmp1-	Rmp1-	Rmp1-	1Fh
		,,,	1				ut-1-en	table-s	table-s	table-s	table-s	1111
								el[3]	el[2]	el[1]	el[0]	
RF1H	Set OTP	W	0	1	1	1	1	0	0	0	1	F1H
	program	W	1	-	-	-	-	-	-	LUT_	reg_ba	03h
			1						_	bank	nk	
RF2H	Read	W	0	1	1	1	1	0	0	1	0	F2H
DEST	checksum	R	1	#	#	#	#	#	#	#	#	-
RF3H	Calculate Checksum	W	0	1	1	1	1	0	0	1	1	F3H
	CHECKSUIII	<u> </u>		1	1	I	l	1	<u> </u>	1	I	l

#### **6-2 Register Description**

6-2.1R00H (PSR): Panel setting Register

R00H		Bit											
Inst/Para	R/W	D/CX	D7	D6	D5	D4	D3	D2	D1	D0	Code		
PSR	W	0	0	0	0	0	0	0	0	0	H00		
1st Parameter	W	1	RES[1]	RES[0]	REG_EN	BWR	UD	SHL	SHD_N	RST_N	8Fh		

NOTE: "-" Don' t care, can be set to VDD or GND level

ription		ommand defin						
	Bit	Name	Description					
			RST_N function					
	0	RST N	1 : no effect. (default)					
		_	0: Booster OFF, Register data are set to their default values, and					
			SEG/BG/VCOM:floating					
			SHD_N function					
	1	SHD_N	0: Booster OFF, register data are kept, and SEG/BG/VCOM are kept floating.					
			1 : Booster on. (default)					
			SHL function					
	2	SHL	0: Shift left; First data= $Sn \rightarrow Sn-1 \rightarrow \cdots \rightarrow S2 \rightarrow Last data=S1$ .					
		SIL	1: Shift right: First data= $S1 \rightarrow S2 \rightarrow \cdots \rightarrow Sn-1 \rightarrow Last data=Sn$ .					
		efault)						
			UD function					
	3	UD	0:Scan down; First line= $Gn \rightarrow Gn-1 \rightarrow \cdots \rightarrow G2 \rightarrow Last line=G1$ .					
			1:Scan up; First line=G1 $\rightarrow$ G2 $\rightarrow$ ··· $\rightarrow$ Gn-1 $\rightarrow$ Last line=Gn. (default)					
			Color selection setting					
	4	BWR	0: Pixel with B/W/Red. Run both LU1 and LU2. (default)					
			1: Pixel with B/W. Run LU1 only					
			LUT selection setting					
	5	REG_EN	0: Using LUT from OTP(default)					
			1 : Using LUT from register					
			Resolution setting					
	7.6		00: Display resolution is 96x230					
	7-6	RES[1,0]	01: Display resolution is 96x252					
			10: Display resolution is 128x296 (default)					
			11: Display resolution is 160x296					

- 1. When SHD\_N become low, DCDC will turn off. Register and SRAM data will keep until VDD turn off. SD output and VCOM will base on previous condition and keep floating.
- 2. When RST\_N become low, driver will reset. All register will reset to default value. All of the driver's functions will disable. SD output and VCOM will base on previous condition and keep floating.



6-2-2 R01H (PWR): Power setting Register

R01H							Bit				
Inst/Para	R/W	D/CX	D7	D6	D5	D4	D3	D2	D1	D0	Code
PWR	W	0	0	0	0	0	0	0	0	1	01h
1st Parameter	W	1	-	-	1	ı	-	1	VDS_EN	VDS_EN	03h
2nd Parameter	W	1	-	-	-	-	VCOM_ HV	VGHL_L V [2]	VGHL_L V [1]	VGHL_L V [0]	00h
3rd Parameter	W	1	-	-	VSH [5]	VSH [4]	VSH [3]	VSH [2]	VSH [1]	VSH [0]	26h
4th Parameter	W	1	-	-	VSL [5]	VSL [4]	VSL [3]	VSL [2]	VSL [1]	VSL [0]	26h
5th Parameter	W	1	-	VSHR [6]	VSHR [5]	VSHR [4]	VSHR [3]	VSHR [2]	VSHR [1]	VSHR [0]	06h

NOTE: "-" Don't care, can be set to VDD or GND level

Description -The command defines as :E4

1st Parameter:

Bit	Name	Description
		Source power selection.
0	VDG_EN	0 : External source power from VSH/VSL/VSHR pins.
		1 : Internal DC/DC function for generate VSH/VSL/VSHR (default)
		Source power selection.
1	VDS_EN	0 : External source power from VSH/VSL/VSHR pins.
		1 : Internal DC/DC function for generate VSH/VSL/VSHR (default)

#### 2nd Parameter:

Bit	Name	Description
		VGHL_LV Voltage Level.
		000: VGH=20 v, VGL=-20v
		001: VGH=19 v, VGL=-19v
		010: VGH=18 v, VGL=-18v
2-0	VGHL_LV	011: VGH=17 v, VGL=-17v
		100: VGH=16 v, VGL=-16v
		101: VGH=15 v, VGL=-15v
		110: VGH=14 v, VGL=-14v
		111: VGH=13 v, VGL=-13v
		VCOM Voltage Level
3	VCOM HV	0:
3	V COM_H V	VCOMH=VSH+VCOMDC,VCOML=VSL+VCOMDC(default)
		1: VCOMH=VGH, VCOML=VGL



3rd Parameter: Internal VSH power selection for B/W LUT.										
Bit	Nam e	Description								
		Internal VSH pow	ver select	ion.	_					
		VSH[5:0]		Voltage(V	VSH[5:0]		Voltage(V)			
		000000	00h	2.4	100000	20h	8.8			
		000001	01h	2.6	100001	21h	9			
		000010	02h	2.8	100010	22h	9.2			
		000011	03h	3	100011	23h	9.4			
		000100	04h	3.2	100100	24h	9.6			
		000101	05h	3.4	100101	25h	9.8			
		000110	06h	3.6	100110	26h	10			
		000111	07h	3.8	100111	27h	10.2			
,		001000	08h	4	101000	28h	10.4			
		001001	09h	4.2	101001	29h	10.6			
		001010	0Ah	4.4	101010	2Ah	10.8			
		001011	0Bh	4.6	101011	2Bh	11			
		001100	0Ch	4.8	101100	2Ch	11.2			
		001101	0Dh	5	101101	2Dh	11.4			
5.0	YOU	001110	0Eh	5.2	101110	2Eh	11.6			
5-0	VSH	001111	0Fh	5.4	101111	2Fh	11.8			
		010000	10h	5.6	110000	30h	12			
		010001	11h	5.8	110001	31h	12.2			
		010010	12h	6	110010	32h	12.4			
		010011	13h	6.2	110011	33h	12.6			
		010100	14h	6.4	110100	34h	12.8			
		010101	15h	6.6	110101	35h	13			
		010110	16h	6.8	110110	36h	13.2			
		010111	17h	7	110111	37h	13.4			
		011000	18h	7.2	111000	38h	13.6			
		011001	19h	7.4	111001	39h	13.8			
		011010	1Ah	7.6	111010	3Ah	14			
		011011	1Bh	7.8	111011	3Bh	14.2			
		011100	1Ch	8	111100	3Ch	14.4			
		011101	1Dh	8.2	111101	3Dh	14.6			
		011110	1Eh	8.4	111110	3Eh	14.8			
		011111	1Fh	8.6	111111	3Fh	15			



Bit	Name	Description Internal VSH po	wer selec	ction.			
		VSH[5:0]		Voltage(V)	VSH[5:0]		Voltage(V)
		000000	00h	-2.4	100000	20h	-8.8
		000001	01h	-2.6	100001	21h	-9
		000010	02h	-2.8	100010	22h	-9.2
		000011	03h	-3	100011	23h	-9.4
		000100	04h	-3.2	100100	24h	-9.6
		000101	05h	-3.4	100101	25h	-9.8
		000110	06h	-3.6	100110	26h	-10
		000111	07h	-3.8	100111	27h	-10.2
		001000	08h	-4	101000	28h	-10.4
		001001	09h	-4.2	101001	29h	-10.6
		001010	0Ah	-4.4	101010	2Ah	-10.8
		001011	0Bh	-4.6	101011	2Bh	-11
		001100	0Ch	-4.8	101100	2Ch	-11.2
		001101	0Dh	-5	101101	2Dh	-11.4
5-0	VSL	001110	0Eh	-5.2	101110	2Eh	-11.6
3-0	VSL	001111	0Fh	-5.4	101111	2Fh	-11.8
		010000	10h	-5.6	110000	30h	-12
		010001	11h	-5.8	110001	31h	-12.2
		010010	12h	-6	110010	32h	-12.4
		010011	13h	-6.2	110011	33h	-12.6
		010100	14h	-6.4	110100	34h	-12.8
		010101	15h	-6.6	110101	35h	-13
		010110	16h	-6.8	110110	36h	-13.2
		010111	17h	-7	110111	37h	-13.4
		011000	18h	-7.2	111000	38h	-13.6
		011001	19h	-7.4	111001	39h	-13.8
		011010	1Ah	-7.6	111010	3Ah	-14
		011011	1Bh	-7.8	111011	3Bh	-14.2
		011100	1Ch	-8	111100	3Ch	-14.4
		011101	1Dh	-8.2	111101	3Dh	-14.6
		011110	1Eh	-8.4	111110	3Eh	-14.8
		011111	1Fh	-8.6	111111	3Fh	-15

Juir	arameter: In	ternal VSHR power selection for Red LUT.									
Bit	Name					Descri	ption				
		Internal VSH	powers	selection	•						
		VSH[5:	0]	Volta ge(V)	VSH[5	5:0]	Volta ge(V)	VSHR[6	5:0]	Voltage(V)	
		0000000	00h	2.4	0011101	1Dh	5.3	0111010	3Ah	8.2	
		0000001	01h	2.5	0011110	1Eh	5.4	0111011	3Bh	8.3	
		0000010	02h	2.6	0011111	1Fh	5.5	0111100	3Bh	8.4	
		0000011	03h	2.7	0100000	20h	5.6	0111101	3Dh	8.5	
		0000100	04h	2.8	0100001	21h	5.7	0111110	3Eh	8.6	
		0000101	05h	2.9	0100010	22h	5.8	0111111	3Fh	8.7	
		0000110	06h	3.	0100011	23h	5.9	0111111	40h	8.8	
		0000111	07h	3.1	0100100	24h	6.0	1000001	41h	8.9	
		0001000	08h	3.2	0100101	25h	6.1	1000010	42h	9	
		0001001	09h	3.3	0100110	26h	6.2	1000011	43h	9.1	
		0001010	0A h	3.4	0100111	27h	6.3	1000100	44h	9.2	
		0001011	0Bh	3.5	0101000	28h	6.4	1000101	45h	9.3	
		0001100	0Ch	3.6	0101001	29h	6.5	1000110	46h	9.4	
6-0	VSHR	0001101	0D h	3.7	0101010	2Ah	6.6	1000111	47h	9.5	
		0001110	0Eh	3.8	0101011	2Bh	6.7	1001000	48h	9.6	
		0001111	0Fh	3.9	0101100	2Ch	6.8	1001001	49h	9.7	
		0010000	10h	4	0101101	2Dh	6.9	1001010	4Ah	9.8	
		0010001	11h	4.1	0101110	2Eh	7	1001011	4Ah	9.9	
		0010010	12h	4.2	0101111	2Fh	7.1	1001100	4Ch	10	
		0010011	13h	4.3	0110000	30h	7.2	1001101	4Dh	10.1	
		0010100	14h	4.4	0110001	31h	7.3	1001110	4Eh	10.2	
		0010101	15h	4.5	0110010	32h	7.4	1001110	4Eh	10.3	
		0010110	16h	4.6	0110011	33h	7.5	1010000	50h	10.4	
		0010111	17h	4.7	0110100	34h	7.6	1010001	51h	10.5	
		0011000	18h	4.8	0110101	35h	7.7	1010010	52h	10.6	
		0011001	19h	4.9	0110110	36h	7.8	1010010	53h	10.7	
		0011010	1A h	5	0110111	37h	7.9	1010100	53h	10.8	
		0011011	1Bh	5.1	0111000	38h	8	1010101	55h	10.9	
		0011100	1Ch	5.2	0111001	39h	8.1	1010110	56h	11	
		Note: 1.VSH>VS	HR								



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6.2.3 R02H (POF): Power OFF Command

R02H		Bit											
Inst/Para	R/W	D/CX	D7	D6	D5	D4	D3	D2	D1	D0	Code		
POF	W	0	0	0	0	0	0	0	1	0	02H		

NOTE: "-" Don't care, can be set to VDD or GND level

1101E. D	on teare, can be set to VBB of GIAB level
Description	-The command defines as :
	● After power off command, driver will power off base on power off sequence.
	● After power off command, BUSY_N signal will drop from high to low. When finish the
	power off sequence, BUSY_N singal will rise from low to high.
	● Power off command will turn off charge pump, T-con, source driver, gate driver, VCOM, temperature sensor, but register and SRAM data will keep until VDD off.
	●SD output and VCOM will keep floating.
Restriction	

6.2.4 R03H (PFS): Power off Sequence Setting Register

R03H		Bit										
Inst/Para	R/ W	D/C X	D7	D6	D5	D4	D3	D2	D1	D0	Code	
PFS	W	0	0	0	0	0	0	0	1	1	03H	
1st Parameter	W	1	-	-	Vsh_of f[1]	Vsh_of f [0]	Vsl_of f[1]	vsl_o ff[0]	vshr_ off[1]	vshr_off [0]	00h	

NOTE: "-" Don't care, can be set to VDD or GND level

Description	-The	command defin	ies as :
	1st	Parameter:	
	Bit	Name	Description
			00: 5ms. (default)
	1-0	wahn off	01: 10ms
	1-0	vshr_off	10: 20ms
			11: 40ms
			00: 5ms. (default)
	3-2	val off	01: 10ms
	3-2	vsl_off	10: 20ms
			11: 40ms
			00: 5ms. (default)
	E 1	wah off	01: 10ms
	5-4	vsh_off	10: 20ms
			11: 40ms
Restriction		<u> </u>	

6.2.5 R04H (PON): Power ON Command

R04H		Bit										
Inst/Para	R/W	D/CX	D7	D6	D5	D4	D3	D2	D1	D0	Code	
PON	W	0	0	0	0	0	0	1	0	0	04H	

NOTE: "-" Don't care, can be set to VDD or GND level

Description	-The command defines as :
	● After power on command, driver will power on base on power on sequence.
	● After power on command, BUSY_N signal will drop from high to low. When finishing the power off
	sequence, BUSY_N signal will rise from low to high.
Restriction	

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6.2.6 R05H (PMES): Power ON Measure Command

R05H		Bit											
Inst/Para	R/W	D/CX	D7	D6	D5	D4	D3	D2	D1	D0	Code		
PMES	W	0	0	0	0	0	0	1	0	1	05H		

NOTE: "-" Don't care, can be set to VDD or GND level

	<del></del>
Description	-The command defines as :
	■If user wants to read temperature sensor or detect low power in power off mode, user has to send this command. After power on measure command, driver will switch on relevant commend with Low Power detection (R51H) and temperature measurement. (R40H).
Restriction	

6.2.7 R06H (BTST): Booster Soft Start Command

0.207 10001	(B151): Booster Bott Start Command											
R06H						Bi	t					
Inst/Para	R/ W	D/CX	D7	D6	D5	D4	D3	D2	D1	D0	Code	
BTST	W	0	0	0	0	0	0	1	1	0	06H	
1st Paramete r	W	1	BT_PH A7	BT_PH A6	BT_PH A5	BT_PHA 4	BT_PHA 3	BT_PHA 2	BT_PHA 1	BT_PHA 0	17h	
2nd Paramete r	W	1	BT_PH B7	BT_PH B6	BT_PH B5	BT_PHB 4	BT_PHB	BT_PHB 2	BT_PHB 1	BT_PHB 0	17h	
3rd Paramete r	W	1	-	-	BT_PH C5	BT_PHC 4	BT_PHC	BT_PHC 2	BT_PHC 1	BT_PHC 0	17h	

#### -The command define as follows:

#### 1st Parameter:

	1501	D'4	NI	D : .:
		Bit	Name	Description
				000: period 1
				001: period 2
				010: period 3
		2-0		011: period 4
		2-0		100: period 5
				101: period 6
				110: period 7
D:			Driving strength of	111: period 8 (default)
Descri			phase A	000: Strength 1
ption				001: Strength 2
				010: Strength 3 (default)
		5-3		011: Strength 4
		3-3		100: Strength 5
				101: Strength 6
				110: Strength 7
				111: Strength 8
				00: 10mS (default)
		7.6	Soft start period of	01: 20mS
		7-6	phase A	10: 30mS
				11: 40mS

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Restriction

Description	2n	d Parameter:			
_		Bit	Name	Description	
				000: period 1	
				001: period 2	1
				010: period 3	1
		2.0		011: period 4	1
		2-0		100: period 5	
				101: period 6	1
				110: period 7	1
			Driving strength of	111: period 8 (default)	1
			phase B	000: Strength 1	
				001: Strength 2	
				010: Strength 3 (default)	
		5-3		011: Strength 4	
		3-3		100: Strength 5	
				101: Strength 6	
				110: Strength 7	
				111: Strength 8	1
				00: 10mS (default)	
		7-6	Soft start period of	01: 20mS	
			1 1		
			phase B	10: 30mS	
			phase B	10: 30mS 11: 40mS	
			phase B		_
	3rc	l Parameter:		11: 40mS	<u> </u>
	3rc	l Parameter:	Name	11: 40mS  Description	]
	3rc			Description 000: period 1	
	3rc			Description 000: period 1 001: period 2	
	3rc			Description  000: period 1  001: period 2  010: period 3	
	3rc		Name  Minimum OFF time setting of GDR in	Description 000: period 1 001: period 2 010: period 3 011: period 4	
	3rc	Bit	Name  Minimum OFF time	Description  000: period 1  001: period 2  010: period 3  011: period 4  100: period 5	
	3rc	Bit	Name  Minimum OFF time setting of GDR in	Description  000: period 1  001: period 2  010: period 3  011: period 4  100: period 5  101: period 6	
	3rc	Bit	Name  Minimum OFF time setting of GDR in	Description  000: period 1  001: period 2  010: period 3  011: period 4  100: period 5  101: period 6  110: period 7	
	3rc	Bit	Name  Minimum OFF time setting of GDR in	Description  000: period 1  001: period 2  010: period 3  011: period 4  100: period 5  101: period 6  110: period 7  111: period 8 (default)	
	3rc	Bit	Name  Minimum OFF time setting of GDR in	Description  000: period 1  001: period 2  010: period 3  011: period 4  100: period 5  101: period 6  110: period 7  111: period 8 (default)  000: Strength 1	
	3rc	Bit	Name  Minimum OFF time setting of GDR in	Description  000: period 1  001: period 2  010: period 3  011: period 4  100: period 5  101: period 6  110: period 7  111: period 8 (default)  000: Strength 1  001: Strength 2	
	3rcc	2-0	Name  Minimum OFF time setting of GDR in phase C	Description  000: period 1  001: period 2  010: period 3  011: period 4  100: period 5  101: period 6  110: period 7  111: period 8 (default)  000: Strength 1  001: Strength 2  010: Strength 3 (default)	
	3rc	Bit	Name  Minimum OFF time setting of GDR in phase C  Driving strength of	Description  000: period 1  001: period 2  010: period 3  011: period 4  100: period 5  101: period 6  110: period 7  111: period 8 (default)  000: Strength 1  001: Strength 2  010: Strength 4	
	3rc	2-0	Name  Minimum OFF time setting of GDR in phase C	Description  000: period 1  001: period 2  010: period 3  011: period 4  100: period 5  101: period 6  110: period 7  111: period 8 (default)  000: Strength 1  001: Strength 2  010: Strength 3 (default)  011: Strength 4  100: Strength 5	
	3rc	2-0	Name  Minimum OFF time setting of GDR in phase C  Driving strength of	Description  000: period 1  001: period 2  010: period 3  011: period 4  100: period 5  101: period 6  110: period 7  111: period 8 (default)  000: Strength 1  001: Strength 2  010: Strength 4	



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**6.2.8** R07H (DSLP): Deep Sleep

R07H	Bit										
Inst/Para	R/W	D/CX	D7	D6	D5	D4	D3	D2	D1	D0	Code
DSLP	W	0	0	0	0	0	0	1	1	1	07H
1st Parameter	W	1	1	0	1	0	0	1	0	1	A5h

NOTE: "-" Don't care, can be set to VDD or GND level

	The command define as follows:
Danamintian	After this command is transmitted, the chip would enter the deep-sleep mode to save power.
Description	The deep sleep mode would return to standby by hardware reset.
	The only one parameter is a check code, the command would be excited if check code = $0xA5$ .
Restriction	

6.2.9 R10H (DTM1): Data Start transmission 1 Register

R10H						Bit					
Inst/Para	R/W	D/C X	D7	D6	D5	D4	D3	D2	D1	D0	Code
DTM1	W	0	0	0	0	1	0	0	0	0	10H
1st Parameter	W	1	KPixel 1	KPixel2	KPixel3	KPixel 4	KPixel5	KPixel6	KPixel 7	KPixel 8	00Н
2nd Parameter	W	1									00Н
	W	1									00H
Mth Parameter	W	1	KPixel (n-7)	KPixel(n -6)	KPixel(n -5)	KPixel (n-4)	KPixel(n -3)	KPixel(n-2)	KPixel (n-1)	KPixel (n)	Н00

NOTE: "-" Don't care, can be set to VDD or GND level

	The command define as follows:
Description	The register is indicates that user start to transmit data, then write to SRAM. While data transmission complete, user must send command 11H. Then chip will start to send data/VCOM for panel.
1	In B/W mode, this command writes "OLD" data to SRAM.
	In B/W/Red mode, this command writes "B/W" data to SRAM.
	In Program mode, this command writes "OTP" data to SRAM for programming.
Restriction	

6.2.10 R11H (DSP): Data Stop Command

R11H		Bit									
Inst/Para	R/W	D/CX	D7	D6	D5	D4	D3	D2	D1	D0	Code
DSP	W	0	0	0	0	1	0	0	0	1	11H
1st Parameter	R	1	Data_flag	-	-	-	-	-	-	-	-

NOTE: "-" Don't care, can be set to VDD or GND level

Description	-The c	command o	defines as :							
		ile finished nation.	I the data transmitting, user must send this command to driver and read Data_flag							
	1st Parameter:									
	Bit	Bit Name Description								

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	7	-	0: Driver didn't receive all the data. 1: Driver has already received all of the one frame data.						
			t" (10h) or "Data Stop" (11h) commands and when data_flag=1, BUSY_N signal will the refreshing of panel starts.						
Restriction									

6.2.11 R12H (DRF): Display Refresh Command

R12H						Bi	it				
Inst/Para	R/W	D/CX	D7	D6	D5	D4	D3	D2	D1	D0	Code
DRF	W	0	0	0	0	1	0	0	1	0	12H

NOTE: "-" Don't care, can be set to VDD or GND level

Description	-The command defines as :
	■ While users send this command, driver will refresh display (data/VCOM) base on SRAM data and LUT. After display refresh command, BUSY_N signal will become "0".
Restriction	This command only actives when BUSY_N = "1".

6.2.12 R13H (DTM2): Data Start transmission 2 Register

012112 1111	(												
R13H		Bit											
Inst/Para	R/W	D/CX	D7	D6	D5	D4	D3	D2	D1	D0	Code		
DTM2	W	0	0	0	0	1	0	0	1	1	13H		
1st Parameter	W	1	KPixe 11	KPixel 2	KPixel 3	KPixel4	KPixel5	KPixel6	KPixel7	KPixel 8	00H		
2nd Parameter	W	1									00Н		
	W	1									00H		
Mth Parameter	W	1	KPixe l(n-7)	KPixel (n-6)	KPixel( n-5)	KPixel(n -4)	KPixel(n -3)	KPixel(n -2)	KPixel(n -1)	KPixel (n)	00H		

NOTE: "-" Don't care, can be set to VDD or GND level

Description	The command define as follows:
	The register is indicates that user start to transmit data, then write to SRAM. While data transmission complete, user must send command 11H. Then chip will start to send data/VCOM for panel. In B/W mode, this command writes "NEW" data to SRAM. In B/W/Red mode, this command writes "RED" data to SRAM.
Restriction	



6.2.13 R14H (PDTM1): Partial Data Start transmission 1 Register

R14H							Bit				
Inst/Para	R/ W	D/CX	D7	D6	D5	D4	D3	D2	D1	D0	Code
PDTM1	W	0	0	0	0	1	0	1	0	0	14H
1st Parameter	W	1	X[7]	X[6]	X[5]	X[4]	X[3]	0	0	0	00h
2nd Parameter										Y[8]	00h
3rd Parameter	W	1	Y[7]	Y[6]	Y[5]	Y[4]	Y[3]	Y[2]	Y[1]	Y[0]	00h
4th Parameter	W	1	W[7]	W[6]	W[5]	W[4]	W[3]	0	0	0	00h
5th Parameter										L[8]	00h
6th Parameter	W	1	L[7]	L[6]	L[5]	L[4]	L[3]	L[2]	L[1]	L[0]	00h
7th Parameter	W	1	KPix el1	KPixe 12	KPix el3	KPix el4	KPixel 5	KPixel 6	KPixel7	KPixel8	00h
	W	1									00h
Mth Parameter	W	1	KPix el(n-7	KPixe l(n-6)	KPix el(n-5	KPix el(n-4	KPixel( n-3)	KPixel( n-2)	KPixel(n -1)	KPixel(n	00h

NOTE: "-" Don't care, can be set to VDD or GND level

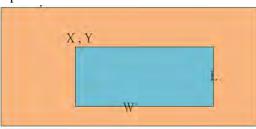
### Description The command define as follows:

The register is indicates that user start to transmit data, then write to SRAM. While data transmission complete, user must send command 11H. Then chip will start to send data/VCOM for panel.

In B/W mode, this command writes "OLD" data to SRAM.

In B/W/Red mode, this command writes "B/W" data to SRAM.

Partial update location and area



Note: X and W should be the multiple of 8.

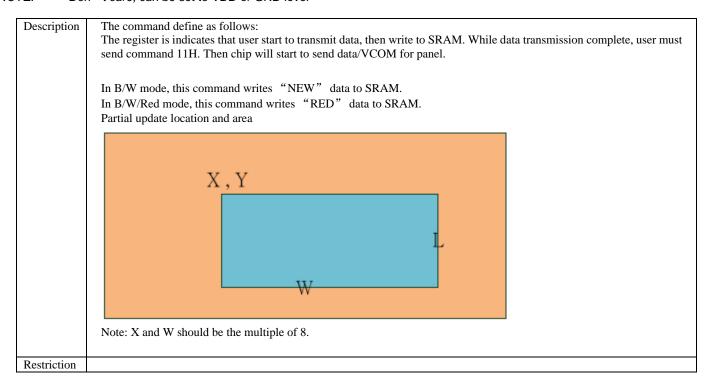
Restriction



6.2.14 R15H (PDTM2): Partial Data Start transmission 2 Register

R15H							Bit				
Inst/Para	R/ W	D/CX	D7	D6	D5	D4	D3	D2	D1	D0	Code
PDTM2	W	0	0	0	0	1	0	1	0	0	15H
1st Parameter	W	1	X[7]	X[6]	X[5]	X[4]	X[3]	0	0	0	00h
2nd Parameter										Y[8]	00h
3rd Parameter	W		Y[7]	Y[6]	Y[5]	Y[4]	Y[3]	Y[2]	Y[1]	Y[0]	00h
4th Parameter	W	1	W[7]	W[6]	W[5]	W[4]	W[3]	0	0	0	00h
5th Parameter										L[8]	00h
6th Parameter	W	1	W[7]	W[6]	W[5]	W[4]	W[3]	0	0	0	00h
7th Parameter	W	1	KPix el1	KPix el2	KPixel 3	KPixel4	KPixel5	KPixel6	KPixel7	KPixel8	00h
	W	1									00h
Mth Parameter	W	1	KPix el(n-7)	KPix el(n-6	KPixel( n-5)	KPixel(n -4)	KPixel(n -3)	KPixel(n -2)	KPixel(n -1)	KPixel(n	00h

NOTE: "-" Don' t care, can be set to VDD or GND level





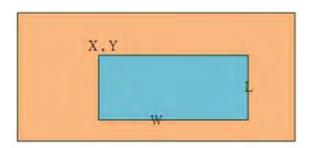
6.2.15 R16H (PDRF): Partial Display Refresh Command

R16H						Bit					
Inst/Para	R/W	D/CX	D7	D6	D5	D4	D3	D2	D1	D0	Code
PDRF	W	0	0	0	0	1	0	1	1	0	16H
1st Parameter	W	1	X[7]	X[6]	X[5]	X[4]	X[3]	0	0	0	00h
			DFV_EN							Y[8]	00h
3rd Parameter	W	1	Y[7]	Y[6]	Y[5]	Y[4]	Y[3]	Y[2]	Y[1]	Y[0]	00h
4th Parameter	W	1	W[7]	W[6]	W[5]	W[4]	W[3]	0	0	0	00h
										L[8]	00h
6th Parameter	W	1	L[7]	L[6]	L[5]	L[4]	L[3]	L[2]	L[1]	L[0]	00h

NOTE: "-" Don't care, can be set to VDD or GND level

Description | -The command define as follows:

While user sent this command, driver will refresh display (data/VCOM) base on SRAM data and LUT. Only the area (X,Y, W, L) would update, the others pixel output would follow VCOM LUT



Note: X and W should be the multiple of 8.

DFV\_EN: data follow VCOM function on display area.

DFV\_EN=1: Only effective in B/W mode, if pixel from "New data" SRAM equal to "Old data" SRAM on display area, this pixel output would follow VCOM LUT.

DFV\_EN=0: Data doesn't follow VCOM LUT.

Restriction this command only active when BUSY\_N = "1".

6.2.16 R20H (LUTC): LUT for Vcom

R20H						Bit						
Inst/Para	R/W	D/CX	D7	D6	D5	D4	D3	D2	D1	D0	Code	
LUTC	W	0	0	0	1	0	0	0	0	0	20H	
1st Parameter	W	1		t Level selection [1:0] 2nd Level selection 3rd Level selection [1:0] 4th level selection [1:0]							00h	
2nd Parameter	W	1		1st Frame number [7:0]								
3rd Parameter	W	1		2nd Frame number [7:0]								
4th Parameter	W	1		3rd Frame number [7:0]								
5th Parameter	W	1				4th Frame	number [7	:0]			00h	
6th Parameter	W	1				Repeat nu	ımbers[7:0	]			00h	
7th~13th	W	1				2nd	state				00h	
Parameter	W	1		3rd ~9th state								
55th ~60h Parameter	W	1	- HDD	CND 1		10th	ı state				00h	

NOTE: "-" Don't care, can be set to VDD or GND level

Description	-The command defines as:							
	one state and is stored with 6 bytes, w	Up Table with 10 states of data. Each group contains information for thile the sixth byte indicates how many times that phase will repeat. choose 7~10 groups by R26H (SET_STG) s are used.						
	define	description						
	Level selection [1:0]	00: -VCM_DC						
		01: VSH+VCM_DC.						
		10: VSL+VCM_DC.						
		11: Floating.						
	Frame number [7:0]	00000000 :0 frame						
		00000001: 1 frame						
		11111110: 254 frame						
		11111111: 255 frame						
	Repeat numbers [7:0]	00000000 : 0						
		00000001: 1						
		11111110: 254						
		11111111: 255						
Restriction	- This command only actives when B	$USY_N = "1".$						

6.2.17 R21H (LUTWW): White to White LUT Register

R21H		Bit										
Inst/Para	R/W	D/CX	D7	D6	D5	D4	D3	D2	D1	D0	Code	
LUTWW	W	0	0	0	1	0	0	0	0	0	21H	
1st Parameter	W	1		1st Level 2nd Level 3rd Level 4th level selection [1:0] selection [1:0] selection [1:0]							00h	
2nd Parameter	W	1		1st Frame number [7:0]								
3rd Parameter	W	1		2nd Frame number [7:0]								
4th Parameter	W	1		3rd Frame number [7:0]								
5th Parameter	W	1			4	th Frame	number [7	:0]			00h	
6th Parameter	W	1				Repeat nu	mbers[7:0	)]			00h	
7th~12th	W	1				2nd	state				00h	
Parameter	W	1		3rd ~6th state								
37th ~42th Parameter	W	1				7th	state				00h	

NOTE: "-" Don't care, can be set to VDD or GND level

Description	-The command defines as:									
	This command stores White-to-White Look-Up Table with 7 groups of data. Each group contains information for one state and is stored with 6 bytes, while the sixth byte indicates how many times that phase will repeat.									
	define	description								
	Level selection [1:0]	00: GND								
		01: VSH								
		10: VSL								
		11: VSHR								
	Frame number [7:0]	00000000 :0 frame								
		00000001: 1 frame								
		11111110: 254 frame								
		11111111: 255 frame								
	Repeat numbers [7:0]	00000000 : 0 time								
		00000001: 1 time								
		11111110: 254 times								
		11111111: 255 times								
Restriction	- This command only actives when BUSY	Y_N = "1".								

6.2.18 R22H (LUTBW/LUTR): Black to White LUT or Red LUT Register

R22H			•			Bit	_					
Inst/Para	R/W	D/CX	D7	D6	D5	D4	D3	D2	D1	D0	Code	
LUTBW/L UTR	W	0	0	0	1	0	0	0	1	0	22H	
1st Parameter	W	1		st Level selection [1:0] 2nd Level selection [1:0] 3rd Level selection [1:0] 4th level selection[1:0]							00h	
2nd Parameter	W	1		1st Frame number [7:0]								
3rd Parameter	W	1		2nd Frame number [7:0]								
4th Parameter	W	1		3rd Frame number [7:0]								
5th Parameter	W	1				4th Frame n	umber [7:0	]			00h	
6th Parameter	W	1				Repeat nur	mbers[7:0]				00h	
7th~12th	W	1				2nd	state				00h	
Parameter	W	1		3rd ~9th state								
55th ~60th Parameter	W	1				10th	state				00h	

NOTE: "-" Don't care, can be set to VDD or GND level

Description	-The command defines as:										
	This command stores White-to-White Look-Up Table with 10 groups of data. Each group contains information for one state and is stored with 6 bytes, while the sixth byte indicates how many times that phase will repeat.  If BWR=0 (BWR mode), User could choose 7~10 groups by R26H (SET_STG)  If BWR=1 (BW mode), only 7 groups are used.										
	define	description									
	Level selection [1:0]	00: GND									
	01: VSH										
		10: VSL									
		11: VSHR									
	Frame number [7:0]	00000000 :0 frame									
		00000001: 1 frame									
		11111110: 254 frame									
		11111111: 255 frame									
	Repeat numbers [7:0]	00000000 : 0 time									
		00000001: 1 time									
		11111110: 254 times									
		11111111: 255 times									
Restriction	- This command only actives when BUSY	_N = "1".									

6.2.19 R23H (LUTWB/LUTW): White to Black LUT or White LUT Register

R23H						Bit						
Inst/Para	R/W	D/CX	D7	D6	D5	D4	D3	D2	D1	D0	Code	
LUTBW/L UTR	W	0	0	0	1	0	0	0	1	1	23H	
1st Parameter	W	1		st Level selection [1:0] 2nd Level selection [1:0] 3rd Level selection [1:0] 4th level selection[1:0]							00h	
2nd Parameter	W	1		1st Frame number [7:0]								
3rd Parameter	W	1		2nd Frame number [7:0]								
4th Parameter	W	1		3rd Frame number [7:0]								
5th Parameter	W	1				4th Frame n	umber [7:0	]			00h	
6th Parameter	W	1				Repeat nu	mbers[7:0]				00h	
7th~12th	W	1				2nd	state				00h	
Parameter	W	1		3rd ~6th state								
37th ~42th Parameter	W	1				7th	state				00h	

NOTE: "-" Don' t care, can be set to VDD or GND level

Description	-The command defines as:											
	This command stores White-to-White Look-Up Table with 7 groups of data. Each group contains information for one state and is stored with 6 bytes, while the sixth byte indicates how many times that phase will repeat.											
	define	description										
	Level selection [1:0]	00: GND										
		01: VSH										
		10: VSL										
		11: VSHR										
	Frame number [7:0]	00000000 :0 frame										
		00000001: 1 frame										
		11111110: 254 frame										
		11111111: 255 frame										
	Repeat numbers [7:0]	00000000 : 0 time										
		00000001: 1 time										
		11111110: 254 times										
		11111111: 255 times										
Restriction	- This command only actives when BUS	Y_N = "1".										

6.2.20 R24H (LUTBB/LUTB): Black to Black LUT or Black LUT Register

R24H						Bit						
Inst/Para	R/W	D/CX	D7	D6	D5	D4	D3	D2	D1	D0	Code	
LUTBB/LU TB	W	0	0	0	1	0	0	1	0	0	24H	
1st Parameter	W	1		st Level selection [1:0] 2nd Level selection [1:0] 3rd Level selection [1:0] 4th level selection[1:0]						00h		
2nd Parameter	W	1		1st Frame number [7:0]								
3rd Parameter	W	1		2nd Frame number [7:0]								
4th Parameter	W	1				3rd Frame n	number [7:0	]			00h	
5th Parameter	W	1				4th Frame n	umber [7:0]	]			00h	
6th Parameter	W	1				Repeat nu	mbers[7:0]				00h	
7th~12th	W	1				2nd	state				00h	
Parameter	W	1		3rd ~6th state								
37th ~42th Parameter	W	1				7th	state				00h	

NOTE: "-" Don't care, can be set to VDD or GND level

Description	-The command defines as:										
	This command stores White-to-White Look-Up Table with 7 groups of data. Each group contains information for one state and is stored with 6 bytes, while the sixth byte indicates how many times that phase will repeat.										
	define	description									
	Level selection [1:0]	00: GND									
		01: VSH									
		10: VSL									
		11: VSHR									
	Frame number [7:0]	00000000 :0 frame									
		00000001: 1 frame									
		11111110: 254 frame									
		11111111: 255 frame									
	Repeat numbers [7:0]	00000000 : 0 time									
		00000001: 1 time									
		11111110: 254 times									
		11111111: 255 times									
Restriction	- This command only actives when BUSY	Y_N = "1".									

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6.2.21 R25H (LUTC Option): LUTC option

R25H	Bit												
Inst/Para	R/W	D/CX	D7         D6         D5         D4         D3         D2         D1         D0								Code		
LUTC option	W	0	0	0 0 1 0 0 0 0							25H		
1st Parameter	W	1		XON [9:8]									
2nd Parameter	W	1		XON [7:0]									
3rd Parameter	W	1		ST_CHV [9:8]									
4th Parameter	W	1				ST_	CHV [7:0]	]			00h		

NOTE: "-" Don't care, can be set to VDD or GND level

Description	-The command defin	nes as:									
	This register is set for	or VCOM LUT.									
	XON[9:0]	All Gate ON									
		000000000: No all gate on.									
		000000001: State1 gate power on									
	1111111111: State1~10 all gate power on										
	ST_CHV[9:0]	Control VCOM Power as High									
		0000000000: No VCOM High voltage									
		000000001: State1 VCOM High voltage									
		1111111111: State1~10 VCOM High voltage									
	W. C. W. C. W. C.										
	Xon function:										
		Frame   Frame 2 Frame 3 Frame 4									
	Xon										
	CLK TLI										
	G0 -										
	G1										
		1/									
	G295										
Restriction	This command on	y actives when BUSY_N = "1".									
Restriction	- This command on	y actives when bos i_iv = 1.									

6.2.22 R26H (SET\_STG): Set VCOM/Red States

R26H		Bit												
Inst/Para	R/W	D/CX	D7	D6	D5	D4	D3	D2	D1	D0	Code			
SET_STG	W	0	0	0	1	0	0	1	1	0	26H			
1st Parameter	W	1			-	-	vcom_stg_sel[1:0] b2w_stg_sel[1:0]			00h				

Description	This comm	nand is used t	to set VCOM/Red LUT states								
	Function of	Function of vcom_stg_sel [1:0]/ b2w_stg_sel[1:0] are shown below									
	Value	Stages									
	00	7									
	01	8									
	10	9									
	11	10									
	Default is	Default is set as 7 stages.									
Restriction	These sett	ings are valid	for BWR mode.								

6.2.23 R30H (OSC): OSC control Register

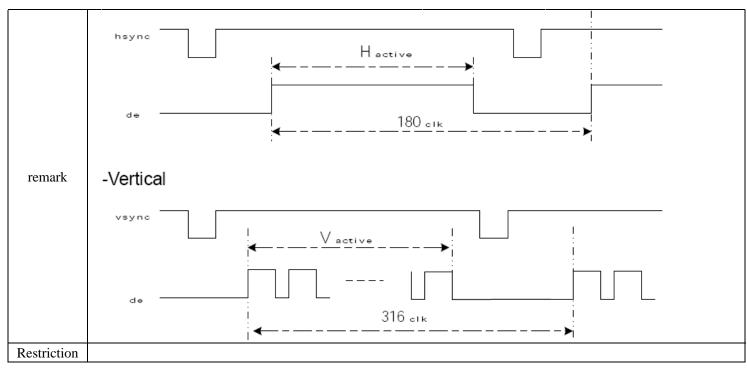
URL: www.buydisplay.com

R30H		Bit											
Inst/Para	R/W	D/CX	D7	D6	D5	D4	D3	D2	D1	D0	Code		
OSC	W	0	0	0	1	1	0	0	0	0	30H		
1st Parameter	W	1	-	-		M[2:0]			3Ah				

NOTE: "-" Don' t care, can be set to VDD or GND level

Description													
	The	e cor	nmand contro	ls the	OSC	C clock freque	ncy. Tl	ne OSC	c structure mus	t suppo	ort the f	following frame rates:	
	M	N	Frame rate	M	N	Frame rate	M	N	Frame rate	M	N	Frame rate	
		1	29HZ		1	86HZ	5	1	150HZ		1	200HZ	
		2	14HZ		2	43HZ		2	72HZ		2	100HZ	
		3	10HZ	3	3	29HZ		3	48HZ		3	67HZ	
	1	4	7HZ		4	21HZ		4	36HZ	7	4	50HZ (default)	
		5	6HZ		5	17HZ		5	29HZ		5	40HZ	
		6	5HZ		6	14HZ		6	24HZ		6	33HZ	
		7	4HZ		7	12HZ		7	20HZ		7	29HZ	
		1	57HZ		1	114HZ		1	171HZ			<u>.</u>	
		2	29HZ		2	57HZ		2	86HZ				
		3	19HZ		3	38HZ		3	57HZ				
	2	4	14HZ	4	4	29HZ	6	4	43HZ				
		5	11HZ		5	23HZ		5	34HZ				
		6	10HZ		6	19HZ		6	29HZ				
		7	8HZ		7	16HZ		7	24HZ				
										•			

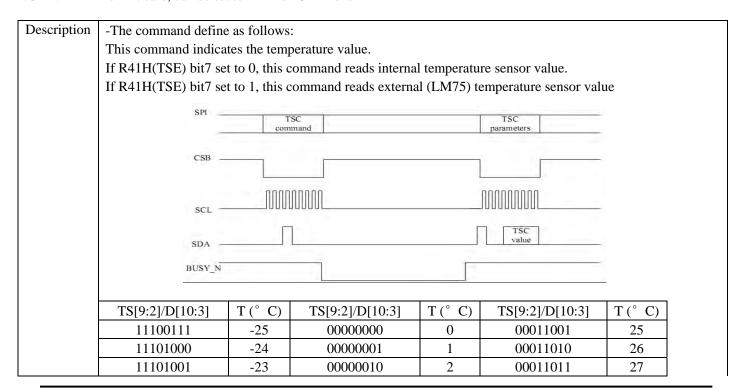
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6.2.24 R40H (TSC): Temperature Sensor Command

R40H						Bit					
Inst/Para	R/W	D/CX	D7	D6	D5	D4	D3	D2	D1	D0	Code
TSC	W	0	0	1	0	0	0	0	0	0	40H
1st Parameter	R	1	D10/TS [9]	D9/TS[8	D8/TS[7	D7/TS[6	D6/TS[5	D5/TS[ 4]	D4/TS[3	D3/T S[2]	-
2nd Parameter	R	1	D2/TS[ 1]	D1/TS[0	D0	-	-	-	-	-	-

NOTE: "-" Don't care, can be set to VDD or GND level





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	11101010	-22	00000011	3	00011100	28
	11101011	-21	00000100	4	00011101	29
	11101100	-20	00000101	5	00011110	30
	11101101	-19	00000110	6	00011111	31
	11101110	-18	00000111	7	00100000	32
	11101111	-17	00001000	8	00100001	33
	11110000	-16	00001001	9	00100010	34
	11110001	-15	00001010	10	00100011	35
	11110010	-14	00001011	11	00100100	36
	11110011	-13	00001100	12	00100101	37
	11110100	-12	00001101	13	00100110	38
	11110101	-11	00001110	14	00100111	39
	11110110	-10	00001111	15	00101000	40
	11110111	-9	00010000	16	00101001	41
	11111000	-8	00010001	17	00101010	42
	11111001	-7	00010010	18	00101011	43
	11111010	-6	00010011	19	00101100	44
	11111011	-5	00010100	20	00101101	45
	11111100	-4	00010101	21	00101110	46
	11111101	-3	00010110	22	00101111	47
	11111110	-2	00010111	23	00110000	48
	11111111	-1	00011000	24	00110001	49
I	TS[1:0] T (° C)	7				
-	00 +0	+				
	01 +0.25	-				
	10 +0.23					

Restriction

This command only actives after R04H(PON) or R05H(PMES)

6.2.25 R41H (TSE): Temperature Sensor Calibration Register

R41H		Bit											
Inst/Para	R/W	D/CX	D7	D6	D5	D4	D3	D2	D1	D0	Code		
TSE	W	0	0	1	0	0	0	0	0	1	41H		
1st Parameter	W	1	TSE	-	-	-	TO[3]	TO[2]	TO[1]	TO[0]	00h		

NOTE: "-" Don' t care, can be set to VDD or GND level

Description	-The	The command defines as:								
	This c	command indicates the driver IC temperature sensor enable and calibration fund	ction.							
	Bit	temperature								
		mean temperature offset value								
		000:0℃								
	2.0	001:1℃								
	2-0	010:2℃								
		···.								
		111:7℃								
		Positive and negative value								
	3	0:" +"								
		1: " - "								

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		Internal temperature sensor enable							
	7	0: Internal temperature sensor enable.(default)							
		1: Internal temperature sensor disable, using external temperature sensor.							
	For e	For example:							
	1100:	: - 4 degree c							
	0111:	: +7 degree c							
Restriction	This	This command only actives after R04H(PON) or R05H(PMES)							

6.2.26 R42H (TSW): Temperature Sensor Write Register

	(	<u>, </u>			<u> </u>								
R42H		Bit											
Inst/Para	R/W	D/CX	D7	D6	D5	D4	D3	D2	D1	D0	Code		
TSW	W	0	0	1	0	0	0	0	1	0	42H		
1st Parameter	W	1	WATTR[7]	WATTR[6]	WATTR[5]	WATTR[4]	WATTR[3]	WATTR[2]	WATTR[1]	WATTR[ 0]	00h		
2nd Parameter	W	1	WMSB[7]	WMSB[6]	WMSB[5]	WMSB[4]	WMSB[3]	WMSB[2]	WMSB[1]	WMSB[0	00h		
3rd Parameter	W	1	WLSB[7]	WLSB[6]	WLSB[5]	WLSB[4]	WLSB[3]	WLSB[2]	WLSB[1]	WLSB[0]	00h		

NOTE: "-" Don' t care, can be set to VDD or GND level

Description	-The command	defines as:					
	This command v	writes the temperature.					
	1st Parameter:						
	Bit	temperature					
	2-0	Pointer setting					
	5-3	User-defined address bits (A2, A1, A0)					
		I2C Write Byte Number					
		00: 1 byte (head byte only)					
	7-6	01: 2 bytes (head byte + pointer)					
		10: 3 bytes (head byte + pointer + 1st parameter)					
		11: 4 bytes (head byte + pointer + 1st parameter + 2nd parameter)					
	2nd Parameter:						
	Bit	temperature					
	7-0	MSByte of write-data to external temperature sensor					
	3nd Parameter:						
	Bit	temperature					
	7-0	LSByte of write-data to external temperature sensor					
Restriction	This command of	only actives after R04H(PON) or R05H(PMES)					

6.2.27 R43H (TSR): Temperature Sensor Read Register

0.2.27 TX-101	7.2.27 K-tori (1916). Temperature benser Keda Kegister												
R43H		Bit											
Inst/Para	R/W	D/CX	D7	D6	D5	D4	D3	D2	D1	D0	Code		
TSC	W	0	0	1	0	0	0	0	0	1	43H		
1st Parameter	R	1	RMSB[7]	RMSB[6	RMSB[5]	RMSB[4]	RMSB[3]	RMSB[2]	RMSB[1	RMSB[0	-		
2nd Parameter	R	1	RLSB[7]	RLSB[6]	RLSB[5]	RLSB[4]	RLSB[3]	RLSB[2]	RLSB[1]	RLSB[0]	-		

NOTE: "-" Don't care, can be set to VDD or GND level

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Description	-The command defines as:							
	This command reads the temperature sensed by the temperature sensor.							
	1st Parameter:							
	Bit	temperature						
	7-0	MSByte of read-data from external temperature sensor						
	2nd Parameter:							
	Bit	temperature						
	7-0	LSByte of write-data from external temperature sensor						
	SPI TSR	TSR						
	command	parameters						
	200							
	CSB							
	ותחחחחחח							
	SCL JUUUUUU							
	TI)	TSR						
	SDA	value						
	BUSY_N							
Restriction	This command only actives after R	204H(PON) or R05H(PMES)						

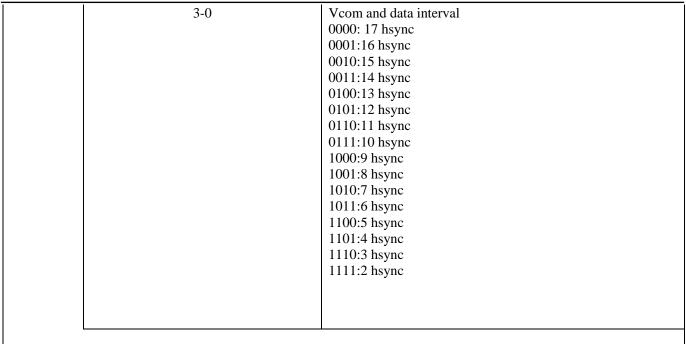
6.2.28 R50H (CDI): VCOM and DATA interval setting Register

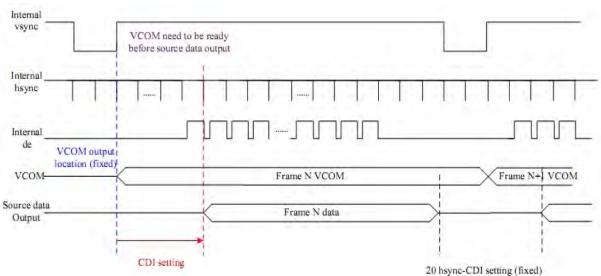
<u> </u>	<del>. (55.)</del>	(02)/1 t 00 in and 27 th times tar outling 1 to grote.									
R50H		Bit									
Inst/Para	R/W	D/CX	D7	D6	D5	D4	D3	D2	D1	D0	Code
CDI	W	0	0	1	0	1	0	0	0	0	50H
1st Parameter	W	1	VBD[1]	VBD[0]	DDX[1]	DDX[0]	CDI[3]	CDI[2]	CDI[1]	CDI[0]	D7h

Description	-The command defines as:	
	1st Parameter:	
	CDI[1:0]: This command indicates the interval of VCOM and data output. When setting the vertical back porch, the total blanking will be keep (20hsync).	
	Bit	



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VBD[1:0] Border data selection.

B/W/Red mode(BWR=0)					
Bit 5-4	Bit7-6	Description			
DDX[0]	[[0] VBD[1:0] LUT				
	00	Floating			
0	01	LUTR			
0	10	LUTW			
	11	LUTB			
	00	LUTB			
1 (default)	01	LUTW			
1 (default)	10	LUTR			
	11 (default)	Floating			
B/W mode (BWR=1)					



Bit 5-4	Bit7-6	description
		-
DDX[0]	VBD[1:0]	LUT
	00	Floating
00	01	LUTBW (1->0)
00	10	LUTWB (0->1)
	11	Floating
	00	Floating
01 (default)	01	LUTWB (1->0)
01 (default)	10	LUTBW (0->1)
	11	Floating

DDX[1:0]: Data polarity

- 1. DDX[1] for RED data, DDX[0] for BW data in the B/W/Red mode
- 2. DDX[0] for B/W mode

$\mathbf{D}/\mathbf{X}\mathbf{X}I$	/D - 1	mode	DIL	$\mathbf{m}  \mathbf{n}$
$\mathbf{K}/\mathbf{W}$	/Rea	model	ки	/R - 0

Bit 5-4	Description	
DDX[1:0]	Data (Red/B/W)	LUT
	00	LUTW
00	01	LUTB
00	10	LUTR
	11	LUTR
	00	LUTB
O1(default)	01	LUTW
01(default)	10	LUTR
	11	LUTR
	00	LUTR
10	01	LUTR
10	10	LUTW
	11	LUTB
	00	LUTR
11	01	LUTR
11	10	LUTB
	11	LUTW

#### B/W mode (BWR=1)

Bit 5-4	Description	
DDX[0]	Data (B/W)	LUT
	00	LUTWW (0->0)
00	01	LUTBW(1->0)
00	10	LUTWB(0->1)
	11	LUTBB(1->1)
	00	LUTBB(0->0)
1 (1-f14)	01	LUTWB(1->0)
1 (default)	10	LUTBW(0->1)
	11	LUTWW(1->1)

6.2.29 R51H (LPD): Lower Power Detection Register

R51H							Bit				
Inst/Para	R/W	D/CX	D7	D6	D5	D4	D3	D2	D1	D0	Code
LPD	W	0	0	1	0	1	0	0	0	1	51H
1st Parameter	R	1	1	-	-	-	-	-	-	LPD	-

NOTE: "-" Don' t care, can be set to VDD or GND level

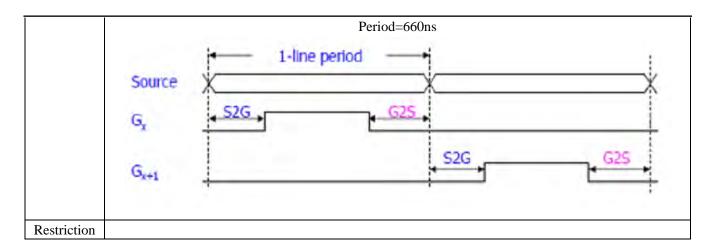
Description	-The command defines as:							
	This command indicates the input power condition. Host can read this data to understand							
	the battery's condition.	the battery's condition.						
	When LPD=" 1", system input power is normal.							
	When LPD=" 0", system input	When LPD="0", system input power is lower (VDD<2.5v, which could be select in RE6H (LVSEL)).						
	1st Parameter:	1st Parameter:						
	Bit 0	LPD						
	0	Low power input.						
	1 Normal status							
Restriction								

6.2.30 R60H (TCON): TCON setting

		(									
R60H		Bit									
Inst/Para	R/W	D/CX	D7	D6	D5	D4	D3	D2	D1	D0	Code
TCON	W	0	0	1	1	0	0	0	0	0	60H
1st Parameter	W	1	S2G[3]	S2G[2]	S2G[1]	S2G[0]	G2S[3]	G2S[2]	G2S[1]	G2S[0]	00h

Description	- The command define Non-overlap period of gate and source as below:					
	1st Parameter:					
	Bit	Period				
	S2G[3:0]/G2S[3:0]	0000: 4 clock(default)				
		0001: 8 clock				
		0010: 12 clock				
		0011:16 clock				
		0100: 20 clock				
		0101: 24 clock				
		0110: 28 clock				
		0111: 32 clock				
		1000: 36 clock				
		1001: 40 clock				
		1010: 44 clock				
		1011: 48 clock				
		1100: 52 clock				
		1101: 56 clock				
		1110: 60 clock				
		1111: 64 clock				
	Period=660ns					





6.2.31 R61H (TRES): Resolution setting

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0.2.01	ROTH (TRES): Resolution setting													
R61H						Bit								
Inst/Para	R/W	D/CX	D7	D6	D5	D4	D3	D2	D1	D0	Code			
TRES	W	0	0	1	1	0	0	0	0	1	61H			
1st Parameter	W	1	HRES( 7)	HRES( 6)	HRES(5	HRES( 4)	HRES(3	-	-	-	00h			
2nd Parameter	W	1								-VRES (8)	00h			
3rd Parameter	W	1	VRES( 7)	VRES( 6)	VRES(5	VRES( 4)	VRES(3	VRES( 2)	VRES(	VRES( 0)	00h			

NOTE: "-" Don' t care, can be set to VDD or GND level

Description	-The command define as follows:							
	When using register:							
	Horizontal display resolution = HRES							
	Vertical display resolution = VRES							
	Channel disable calculation:							
	GD: First G active = G0; LAST active GD= first active +VRES[8:0] -1							
	SD: First active channel: =S0; LAST active SD= first active +HRES[7:3]*8-1							
	EX :128X272							
	GD: First G active = $G0$							
	LAST active GD= 0+272-1= 271; (G271)							
	SD : First active channel: =S0							
Restriction								



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6.2.32 R62H (TSGS): Source & gate start setting

R62H						Bit					
Inst/Para	R/W	D/CX	D7	D6	D5	D4	D3	D2	D1	D0	Code
TSGS	W	0	0	1	1	0	0	0	1	0	62H
1st Parameter	W	1	S_Start (7)	S_Start (6)	S_Start (5)	S_Start (4)	S_Start (3)				00h
2nd Parameter	W	1				gscan		-	-	-G_start [8]	00h
3rd Parameter	W	1	G_Start (7)	G_Start (6)	G_Start (5)	G_Start (4)	G_Start (3)	G_Start (2)	G_Start (1)	G_Start (0)	00h

NOTE: "-" Don' t care, can be set to VDD or GND level

Description	-The command define as follows:							
	1.S_Start [8:0] describe which source output line is the first date line							
	2.G_Start[8:0] describe which gate line is the first scan line							
	gscan :Gate scan select							
	0: Normal scan							
	1: Cascade type 2 scan							
Restriction	S_Start should be the multiple of 8							

6.2.33 R70H (REV): REVISION register

	( + )+ + + <del>g</del> +-												
R70H						Bit							
Inst/Para	R/W	D/CX	D7	D6	D5	D4	D3	D2	D1	D0	Code		
REV	W	0	0	1	1	1	0	0	0	0	70H		
1st Parameter	R	1	REV[7]	REV[6]	REV[5]	REV[4]	REV[3]	REV[2	REV[1]	REV[0	1		
2nd Parameter	R	1	REV[15	REV[14]	REV[13]	REV[12]	REV[11]	REV[1 0]	REV[9]	REV[8	-		

NOTE: "-" Don' t care, can be set to VDD or GND level

Description	-The command define as follows:
	The LUT_REV is read from OTP address = 0x001.& 0x002
Restriction	- This command only actives when BUSY_N = "1".

6.2.34 R71H (FLG): Status register

_		· /												
	R71H		Bit											
	Inst/Para	R/W	D/CX	D7	D6	D5	D4	D3	D2	D1	D0	Code		
Ī	FLG	W	0	0	1	1	1	0	0	0	1	71H		
	1st Parameter	R	1			I2C_ERR	II2C_ BUSYN	Data_flag	PON	POF	BUSY_N	-		

NOTE: "-" Don' t care, can be set to VDD or GND level

Description	-The command defines	as:						
	This command indicate	es the IC status. Host can read this data to understand the IC status.						
	1st Parameter:							
	Bit	Function						
	5	I2C master error status						
	4 I2C master busy status (low active)							

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	3	Driver has already received one frame data						
	2	PON 0: Not in PON mode 1: In PON mode						
	1	POF 0: Not in POF mode(default) 1: In POF mode						
	0	Driver busy status(low active)						
Restriction	User can send this command in any time. It doesn't have restriction of BUSY_N.							

6.2.35 R80H (AMV): Auto Measure VCOM register

R80H		Bit										
Inst/Para	R/W	D/CX	D7	D6	D5	D4	D3	D2	D1	D0	Code	
AMV	W	0	1	0	0	0	0	0	0	0	80H	
1st Parameter	W	1	1	-	AMVT[1]	AMVT[0]	XON	AMVS	AMV	AMVE	10H	

Description	-The	command define as follows:						
	This	command indicates the IC status. Host can read this data to understand the IC status.						
		arameter:						
	Bit	Function						
	0	AMVE: Auto Measure Vcom Setting 0:Auto measure VCOM disable (default) 1: Auto measure VCOM enable						
	AMV: Analog signal  1 0:Get Vcom value from R81h(default)  1:Get Vcom value in analog signal							
	2	AMVS: setting for Source output of AMV 0: Source output 0V during Auto Measure VCOM period. (default) 1: Source output VSHR during Auto Measure VCOM period.						
	3	XON: setting for all Gate ON of AMVB  0: Gate normally scan during Auto Measure VCOM period. (default)  1: All Gate ON during Auto Measure VCOM period.						
	The sensing time of VCOM detection 00: 3s 01: 5s (default) 10: 8s 11: 10s							
Dogtminting.	This	common d only actives when DUCV N "1"						
Restriction	1 ms (	command only actives when $BUSY_N = "1"$ .						



6.2.36 R81H (VV): Vcom Value register

R81H		Bit										
Inst/Para	R/W	D/CX	D7	D6	D5	D4	D3	D2	D1	D0	Code	
VV	W	0	1	0	0	0	0	0	0	1	81H	
1st Parameter	R	1	-	-	VV[5]	VV[4]	VV[3]	VV[2]	VV[1]	VV[0]		

				VDD or GND	level									
Description			mand defines as:											
			mmand could get the Vcom value											
		rameter:												
	Bit 5-0	Function												
	3-0	Vcom valu												
		VCOM	[5:0]	Voltage(V)	VCOM[5:0]		Voltage(V)	VCOM[5:0]		Voltage(V)				
		000000	00h	-0.1	010100	14h	-1.1	101000	28h	-2.1				
		000001	01h	-0.15	010101	15h	-1.15	101001	28h	-2.15				
		000010	02h	-0.2	010110	16h	-1.2	101001	2Ah	-2.2				
		000011	03h	-0.25	010111	17h	-1.25	101011	2Bh	-2.25				
		000100	04h	-0.3	011000	18h	-1.3	101100	2Ch	-2.3				
		000100	05h	-0.35	011001	19h	-1.35	101101	2Dh	-2.35				
		000110	06h	-0.4	011010	1Ah	-1.4	101110	2Eh	-2.4				
		000111	07h	-0.45	011011	1Bh	-1.45	101111	2Fh	-2.45				
		001000	08h	-0.5	011100	1Ch	-1.5	101111	30h	-2.5				
		001001	09h	-0.55	011101	1Dh	-1.55	110001	31h	-2.55				
		001010	0Ah	-0.6	011110	1Eh	-1.6	110010	32h	-2.6				
		001010	0Bh	-0.65	011111	1Fh	-1.65	110011	33h	-2.65				
		001100	0Ch	-0.7	011111	20h	-1.7	110100	34h	-2.7				
		001101	0Dh	-0.75	100001	21h	-1.75	110101	35h	-2.75				
		001110	0Eh	-0.8	100010	22h	-1.8	110110	36h	-2.8				
		001111	0Fh	-0.85	100011	23h	-1.85	110110	37h	-2.85				
		010000	10h	-0.9	100100	24h	-1.9	111000	38h	-2.9				
		010001	10h	-0.95	100100	25h	-1.95	111001	39h	-2.95				
		010010	12h	-1	100110	26h	-2	111010	3Ah	-3				
		010010	13h	-1.05	100111	27h	-2.05							
Restriction	This c	ommand on	ly activ	es when BUS	$Y_N = 1$ .									

6.2.37 R82H (VDCS): Vcom\_DC Setting register

				- 0	-						
Inst/Para	R/W	D/CX	D7	D6	D5	D4	D3	D2	D1	D0	Code
VDCS	W	0	1	0	0	0	0	0	1	0	82H
1st Parameter	W	1	-	-	VCDS[5]	VCDS [4]	VCDS [3]	VCDS [2]	VCDS [1]	VCDS [0]	00h

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Description -The command defines as:
This command set the VCOM DC value. Driver will base on this value for VCM\_DC.

1st Pa	rameter:						_		
Bit	Function								
5-0	VCOM val	ue							
	VCOM[	[5:0]	Voltage(V)	VCOM[:	5:0]	Voltage(V)	VCOM[	5:0]	Voltage(V)
	000000	00h	-0.1	010100	14h	-1.1	101000	28h	-2.1
	000001	01h	-0.15	010101	15h	-1.15	101001	28h	-2.15
	000010	02h	-0.2	010110	16h	-1.2	101001	2Ah	-2.2
	000011	03h	-0.25	010111	17h	-1.25	101011	2Bh	-2.25
	000100	04h	-0.3	011000	18h	-1.3	101100	2Ch	-2.3
	000100	05h	-0.35	011001	19h	-1.35	101101	2Dh	-2.35
	000110	06h	-0.4	011010	1Ah	-1.4	101110	2Eh	-2.4
	000111	07h	-0.45	011011	1Bh	-1.45	101111	2Fh	-2.45
	001000	08h	-0.5	011100	1Ch	-1.5	101111	30h	-2.5
	001001	09h	-0.55	011101	1Dh	-1.55	110001	31h	-2.55
	001010	0Ah	-0.6	011110	1Eh	-1.6	110010	32h	-2.6
	001010	0Bh	-0.65	011111	1Fh	-1.65	110011	33h	-2.65
	001100	0Ch	-0.7	011111	20h	-1.7	110100	34h	-2.7
	001101	0Dh	-0.75	100001	21h	-1.75	110101	35h	-2.75
	001110	0Eh	-0.8	100010	22h	-1.8	110110	36h	-2.8
	001111	0Fh	-0.85	100011	23h	-1.85	110110	37h	-2.85
	010000	10h	-0.9	100100	24h	-1.9	111000	38h	-2.9
	010001	10h	-0.95	100100	25h	-1.95	111001	39h	-2.95
	010010	12h	-1	100110	26h	-2	111010	3Ah	-3

27h

-2.05

Restriction This command only actives when BUSY\_N = "1".

13h

-1.05

010010

#### 6.2.38RA0H (PGM): Program Mode

RA0H						Bit					
Inst/Para	R/W	D/CX	D7	D6	D5	D4	D3	D2	D1	D0	Code
PTIN	W	0	1	0	1	0	0	0	0	0	A0H
1st Parameter	W	1	1	0	1	0	0	1	0	1	A5h

NOTE: "-" Don' t care, can be set to VDD or GND level

Description	-The command define as follows:  After this command is issued, the chip would enter the program mode.  The mode would return to standby by hardware reset.  The only one parameter is a check code, the command would be executed if check code = 0xA5.
Restriction	This command only actives when $BUSY_N = "1"$ .

100111

6.2.39 RA1H (APG): Active Program

RA1H						Bit					
Inst/Para	R/W	D/CX	D7	D6	D5	D4	D3	D2	D1	D0	Code
APG	W	0	1	0	1	0	0	0	0	1	A1H



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Description	-The command define as follows:
	After this command is transmitted, the programming state machine would be activated.
Restriction	The BUSY flag would fall to 0 while the programming is completed.

#### 6.2.40 RA2H (ROTP): Read OTP Data

RA2H				Bit								
Inst/Para	R/W	D/CX	D7	7 D6 D5 D4 D3 D2 D1 D0							Code	
ROTP	W	0	1	1 0 1 0 0 0 1 0							A2H	
1st Parameter	R	1				Dun	nmy				-	
2nd Parameter	R	1		-	The data	of address	s 0x000 i	n the OTI	?		-	
3rd Parameter	R	1		-	Γhe data o	of address	s 0x001 i	n the OTI	P		-	
4th Parameter	R	1									-	
5th Parameter	R	1		The data of address (n-1) in the OTP							-	
6th~ (m-1)th Parameter	R	1									-	
mth Parameter	R	1			The data	of addre	ess (n) in	the OTP			-	

NOTE: "-" Don' t care, can be set to VDD or GND level

Description -The command define as follows: The command is used for reading the content of OTP for checking the data of programming. The value of (n) is depending on the amount of programmed data, the max address = 0xFFF. Supply Power, Reset Into Program Mode (RAOH)) Write data(R10H) Apply VPP=7.5V SET\_OTP\_BANK (RF1H) & Activate program (RA1H) Remap LUT (RF0H) temove VPP Calculate Checksum ROTP (RA2H) (RF3H) Read Checksum information(RF2H) ower off (R02H)the power on (RO4H) Apply VPP=7.5V Program Checksum to OTP(REFH) Remove VPP Finish, Reset The sequence of programming OTP Restriction This command only actives when  $BUSY_N = "1"$ .

6.2.41 RE0H (CCSET): Cascade Setting

RE0H						Е	Bit				
Inst/Para	R/W	D/CX	D7	D6	D5	D4	D3	D2	D1	D0	Code
CCSET	W	0	1	1	1	0	0	0	0	0	ЕОН
1st Parameter	W	1	-	-	-	-	-	-	TSFIX	CCEIN	00h

NOTE: "-" Don't care, can be set to VDD or GND level

Description	This command is	used for cascade.
	1st Parameter:	
	Bit	
	0	Output clock enable/disable. 0: Output 0V at CL pin. (default) 1: Output clock at CL pin for slave chip.
	1	Let the value of slave's temperature is same as the master's. 0: Temperature value is defined by internal temperature sensor / external LM75. (default) 1: Temperature value is defined by TS_SET [7:0] registers.
Restriction	This command on	ly actives when BUSY_N = "1".

**6.2.42 RE5H (TSSET): Force Temperature** 

RE5H						Bit					
Inst/Para	R/W	D/CX	D7	D6	D5	D4	D3	D2	D1	D0	Code
TSSET	W	0	1	1	1	0	0	1	0	1	E5H
1st Parameter	W	1	TS_SE T[7]	TS_SET [6]	TS_SET [5]	TS_SET [4]	TS_SET [3]	TS_SE T[2]	TS_SET [1]	TS_SET [0]	00h

NOTE: "-" Don't care, can be set to VDD or GND level

Description	-The command define as follows:
	This command is used to fix the temperature value of master and salve
Restriction	

6.2.43 RE6H (LVSEL): LVD voltage Select

~		· ~,	• - • - • •	g	~							
	RE6H		Bit									
	Inst/Para	R/W	D/CX	D7	D6	D5	D4	D3	D2	D1	D0	Code
	Select LVD Voltage	W	0	1	1	1	0	0	1	1	0	Е6Н
	1st Parameter	W	1							LVD_SEL[1]	LVD_SEL[0]	03h

Description	LVD_SEL[1:0]: Low power Voltage sele	ection
	LVD_SEL[1:0]	LVD value
	00	< 2.2 V
	01	< 2.3 V
	10	< 2.4 V
	11(default)	< 2.5 V
Restriction		



6.2.44 RE7H (PBC): Panel Break Check

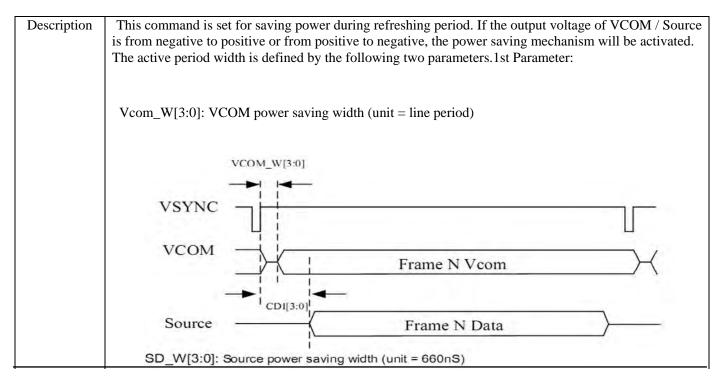
RE7H						Bi	t				
Inst/Para	R/W	D/CX	D7	D6	D5	D4	D3	D2	D1	D0	Code
Select LVD Voltage	W	0	1	1	1	0	0	1	1	1	Е7Н
1st Parameter	R	1								PSTA	-

Description`	This co	mmand is used to enable panel check, and to disable after reading result.  ameter:				
	Bit	PSTA				
	0	Panel check fail (panel broken).				
	1	Panel check pass				
	-					
Restriction						

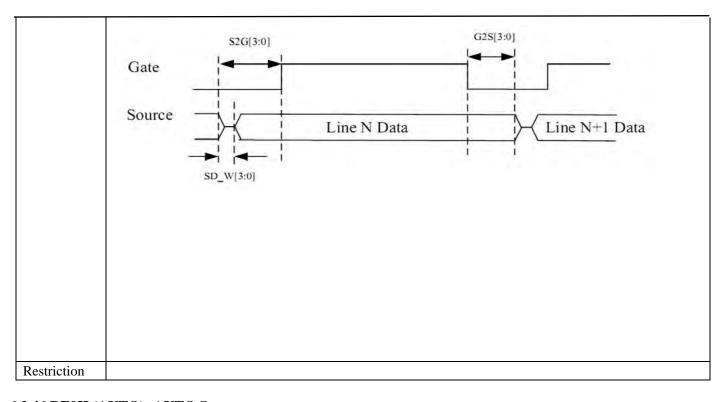
6.2.45 RE8H (PWS): Power Saving

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RE8H						Bit					
Inst/Para	R/W	D/CX	D7	D6	D5	D4	D3	D2	D1	D0	Code
Power Saving	W	0	1	1	1	0	1	0	0	0	Е8Н
1st Parameter	W	1	VCOM_ W[3]	VCOM_ W[2]	VCOM_ W[1]	VCOM_ W[0]	SD_W [3]	SD_W [2]	SD_W [1]	SD_W [0]	00H







6.2.46 RE9H (AUTO): AUTO Sequence

RE9H						Bit					
Inst/Para	R/W	D/CX	D7	D6	D5	D4	D3	D2	D1	D0	Code
AUTO Sequence	W	0	1	1	1	0	1	0	0	1	Е9Н
1st Parameter	W	1	Code[7]	Code[6]	Code[5]	Code[4]	Code[3]	Code[2]	Code[1]	Code[0]	00Н

Description	The command can enable the internal sequence to execute several commands continuously. The successive execution can minimize idle time to avoid unnecessary power consumption and reduce the complexity of host's control procedure. The sequence contains several operations, including PON, DRF, POF, DSLP.
	AUTO (0xE9) + Code(0xA5) = (PON->DRF->POF)
	AUTO (0xE9) + Code(0xA7) = (PON->DRF->POF->DSLP)
Restriction	

6.2.47 REBH (LUT\_BACKUP1\_PG): OTP LUT backup1 program

REBH						Bit					
Inst/Para	R/W	D/CX	D7	D6	D5	D4	D3	D2	D1	D0	Code
CHKSUM_PG	W	1	1	1	1	0	1	0	1	1	EFH

Description	This command is used to Program Checksum of LUT Table
Restriction	Apply VPP to OTP before use this command



6.2.48 RE0H (LUT\_BACKUP1\_RD): Read OTP LUT backup1

RFOH							Bit				
Inst/Para	R/W	D/C X	D7	D6	D5	D4	D3	D2	D1	D0	Code
RM_LUT_CM D	W	0	1	1	1	1	0	0	0	0	F0H
1st Parameter	W	1	-	-	-	tr10_lut_ en	rmp2_table_s el[3]	rmp2_table_s el[2]	rmp2_table_s el[1]	rmp2_tab le_sel[0]	1FH
2nd Parameter	W	1	-	-	-	tr9_lut_e n	rmp1_table_s el[3]	rmp1_table_s el[2]	rmp1_table_s el[1]	rmp1_tab le_sel[0]	1FH

NOTE: "-" Don' t care, can be set to VDD or GND level

Description   The command is used for indicating backup OTP blocks to remap for	for LUTS	
---	----------	--

	Is used for indicating ba	chap off block	I		
Addr (hex)	OTP Bank 0 (3K Bytes)	Addr (hex)	OTP Bank 1 (3K Bytes)		
	•				
00h~0Fh	Temp. segment	C00h~C0Fh	Temp. segment		
20h~60h	Default setting	C20h~C60h	Default setting		
100h	TR0 WF	D00h	TR0 WF		
200h	TR1 WF	E00h	TR1 WF		
300h	TR2 WF	F00h	TR2 WF		
400h	TR3 WF	1000h	TR3 WF		
500h	TR4 WF	1100h	TR4 WF		
600h	TR5 WF	1200h	TR5 WF		
700h	TR6 WF	1300h	TR6 WF		
800h	TR7 WF	1400h	TR7 WF		
900h	TR8 WF	1500h	TR8 WF		
A00h	TR9 WF / Backup 1	1600h	TR9 WF / Backup 1		
B00h	TR10 WF / Backup 2	1700h	TR10 WF / Backup 2		

#### 1st Parameter:

#### tr10\_lut\_en:

Value	Function			
1	OTP Address B00h~BFFh is used as "TR10 WF"			
0	OTP Address B00h~BFFh is used as "Backup 2",			
U	And you can replace one of TR0 ~TR9.			

#### rmp2\_tab\_sel [3:0]:

Only be functional when tr10\_lut\_en is set "0", target LUTs to be replaced is shown below

Value	Target LUTs
0001	TR0
0010	TR1
0011	TR2
0100	TR3
0101	TR4
0110	TR5
0111	TR6
1000	TR7
1001	TR8
1010	TR9
1011~1111	None



2nd Pa	ırameter
440 1224	

tr9\_lut\_en:

Value	Function
1	OTP Address B00h~BFFh is used as "TR9 WF"
0	OTP Address B00h~BFFh is used as "Backup 1",
U	And you can replace one of TR0 ~TR8.

rmp1\_tab\_sel[3:0]

Only be functional when tr9\_lut\_en is set "0", target LUTs to be replaced is shown below

Value	Target LUTs
0001	TR0
0010	TR1
0011	TR2
0100	TR3
0101	TR4
0110	TR5
0111	TR6
1000	TR7
1001	TR8
1010	TR9
1011~1111	None

Notice:

If rmp1\_tab\_sel = rmp2\_tab\_sel, the control hardware will reload "backup 1" block to replace target LUT.

This command only actives when  $BUSY_N = "1"$ . Restriction

6.2.49 RF1H (SET\_OTP\_BANK): Set OTP program bank

RF1H		Bit									
Inst/Para	R/W	D/C X	D7	D6	D5	D4	D3	D2	D1	D0	Code
SET_OTP_ BANK	W	0	1	1	1	1	0	0	0	1	F1H
1st Parameter	W	1			-	-	-	-	LUT_ban k0	reg_ba nk0	03H

Description	This command	This command is used to set program bank for registers and LUTs								
-	Addr (hex)	OTP Bank 0 (3K Bytes)	Addr (hex)	OTP Bank 1 (3K Bytes)						
	00h~0Fh	Temp. segment	C00h~C0Fh	Temp. segment						
	20h~60h	Default setting	C20h~C60h	Default setting						
	100h~BFFh	LUTs	D00h~17FFh	LUTs						
	reg_bank:	eg_bank:								
	Value	Function								
	1	Program "Temp. segr	nent" and "De	efault Setting" in bank 0						
	0	Program "Temp. segr	nent" and "De	efault Setting" in bank 1						
	LUT_bank:									
	Value	Function								
	1	Program "LUTs" in ba	nk 0							
	0	Program "LUTs" in ba	nk 1							
Restriction					_					

#### 6.2.50 RF2H (RD\_CHKSUM): Read checksum information

RF2H	Bit										
Inst/Para	R/W	D/CX	D7	D6	D5	D4	D3	D2	D1	D0	Code
RD_CHKSUM	W	0	1	1	1	1	0	0	1	0	F2H
1st ~9th Parameter	R	1	1 Checksum from "TR0 WF" to "TR8 WF"							-	
10th Parameter	R	1	Checksum of "TR9 WF / backup 1"						-		
11th Parameter	R	1	(	Checksum of "TR10 WF / backup 2"						-	
12th Parameter	R	1	Chec	Checksum comparison result from "TR0 WF" to "TR7 WF"					-		
13th Parameter	R	1	Chec	Checksum comparison result from "TR8" and "TR10 WF / backup 2"					-		

Description	This c	comma	nd is	to read	chec	ksum info	ormation fron	n OTP.			
	1st to	1st to 11th Parameter: Checksum from "TR0 WF" to "TR10 WF / backup 2"									
	12th I	Parame	terco	mmand	is to	read che	cksum inform	nation fron	n OTP.		
	1st to	11th P	aram	eter : Cl	heck	sum from	"TR0 WF" t	o "TR10 V	VF / backup 2"		
	12th I	Parame	ter								
	D7		D6		D:	5	D4	D3	D2	D1	D0
	fault	_TR7	fau	lt_TR6	fai	ult_TR5	fault_TR4	fault_TR	3 fault_TR2	fault_TR1	fault_TR0
	13th I	Parame	ter								
	D7	D6	D5	D4	D3	D2			D1		D0
	-	-	-	-	-	fault_Tl	R10 / fault_ba	ackup2	fault_TR9 / fa	ult_backup1	fault_TR9
				<u> </u>							
	defini	tion of	fault	_TRx /	fault	_backup_	X				
	Valu	Value Function									
	0		Checksum comparison : Equal								
	1		Che	ecksum	com	parison :	Not Equal	_			
Restriction							_				

#### 6.2.51 RF3H (CAL\_CHKSUM): Calculate Checksum

RF3H		Bit									
Inst/Para	R/W	D/CX	D7	D6	D5	D4	D3	D2	D1	D0	Code
CAL_CHKSUM	W	0	1	1	1	0	1	0	1	1	F3H

Description	This command is used to Calculate Checksum of LUT Table
Restriction	



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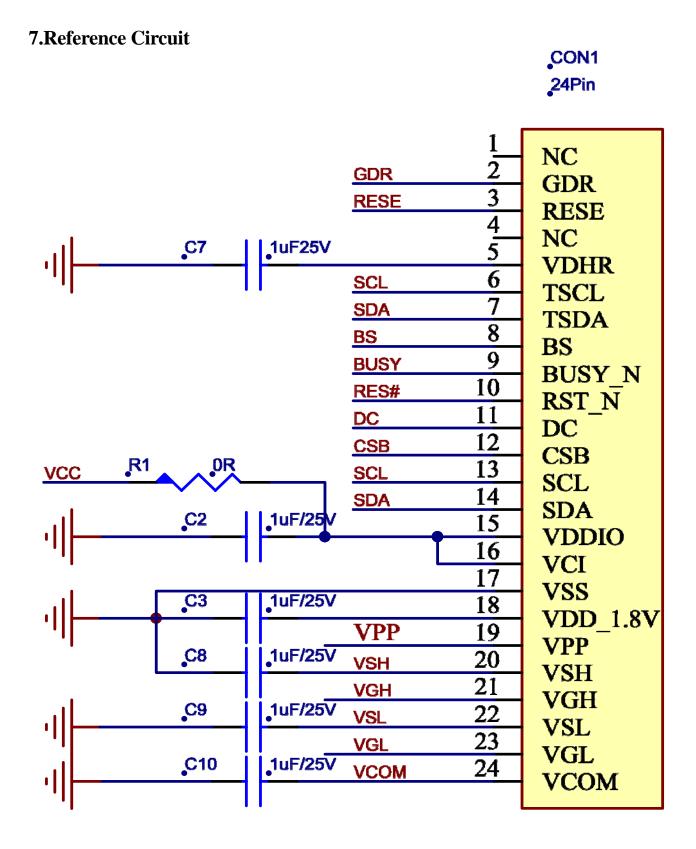
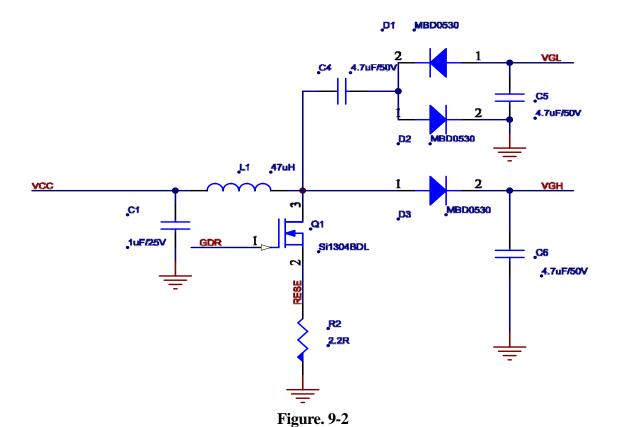


Figure. 7-1

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#### Reference table of the device:

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Part Name	Value/Type	Requirement/Reference Part
C1—C3	1 uF	0603, X5R/X7R, voltage rating : 25V
C4-C9	1uF	0603, X5R/X7R, voltage rating: 50V
C10	0.47uF	0603, X5R/X7R, voltage rating: 25V
D1—D3	Diode	Vishay: MBR0530
R2	2.2 Ω	0603, +/-1% variation
Q1	NMOS	OnSemi: Si1304BDL
L1	47uH	Sumida: CDRH2D18/LDNP-470NC
CON24Pin	0.5mm ZIF Socket	24Pins,0.5mm pitch



#### 8 . ABSOLUTE MAXIMUM RATING

**Table 10-1: Maximum Ratings** 

Symbol	Parameter	Rating	Unit
$V_{CI}$	Logic supply voltage	-0.5 to +6.0	V
$T_{OPR}$	Operation temperature range	0 to 50	°C
$T_{STG}$	Storage temperature range	-25 to 60	°C

Note; Maximum ratings are those values beyond which damages to the device may occur.

Functional operation should be restricted to the limits in the Electrical Characteristics chapter.

Note11-1: Tstg is the transportation condition, the transport time is within 10 days for  $-25^{\circ}\text{C} \sim 0^{\circ}\text{C}$  or  $50^{\circ}\text{C} \sim 60^{\circ}\text{C}$ .

#### 9. DC CHARACTERISTICS

The following specifications apply for: VSS=0V, VCI=3.3V, TOPR=25 °C.

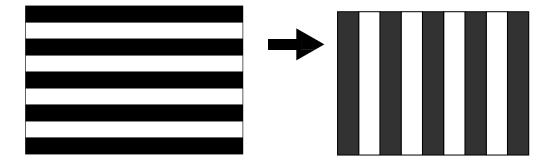
**Table 9-1: DC Characteristics** 

Symbol	Parameter	<b>Test Condition</b>	Applicable pin	Min.	Тур.	Max.	Unit
VCI	VCI operation voltage	-	VCI	2.5	3.3	3.7	V
VIH	High level input voltage	-	SDA, SCL, CS#, D/C#, RES#,	0.8VDDIO	-	-	V
VIL	Low level input voltage	-	BS1	-	-	0.2VDDI	V
						O	
VOH	High level output voltage	IOH = -100uA	BUSY	0.9VDDIO	-	1	V
VOL	Low level output voltage	IOL = 100uA			-	0.1VDDI	V
						O	
Iupdate	Module operating current	-	-	-	2.1	-	mA
Isleep	Deep sleep mode	VCI=3.3V	-	-		1	uA

- The Typical power consumption is measured using associated 25°C waveform with following pattern transition: from horizontal scan pattern to vertical scan pattern. (Note 9-1)
- The listed electrical/optical characteristics are only guaranteed under the controller & waveform provided by XingTai.
- Vcom value will be OTP before in factory or present on the label sticker.

Note 9-1

The Typical power consumption



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### 10. Serial Peripheral Interface Timing

The following specifications apply for: VSS=0V, VCI=2.5V to 3.6V, T<sub>OPR</sub>=25°C

#### Write mode

Symbol	Parameter	Min	Тур	Max	Unit
fSCL	SCL frequency (Write Mode)			20	MHz
tCSSU	Time CSB has to be low before the first rising edge of SCLK	20			ns
tCSHLD	Time CSB has to remain low after the last falling edge of SCLK	20			ns
tCSHIGH	Time CSB has to remain high between two transfers	100			ns
tSCLHIGH	Part of the clock period where SCL has to remain high	25			ns
tSCLLOW	Part of the clock period where SCL has to remain low	25			ns
tSISU	Time SI (SDA Write Mode) has to be stable before the next rising edge of SCL	10			ns
tSIHLD	Time SI (SDA Write Mode) has to remain stable after the rising edge of SCL	40			ns

#### Read mode

Symbol	Parameter	Min	Тур	Max	Unit
fSCL	SCL frequency (Read Mode)			2.5	MHz
tCSSU	Time CSB has to be low before the first rising edge of SCLK	100			ns
tCSHLD	Time CSB has to remain low after the last falling edge of SCLK	50			ns
tCSHIGH	Time CSB has to remain high between two transfers	250			ns
tSCLHIGH	Part of the clock period where SCL has to remain high	180			ns
tSCLLOW	Part of the clock period where SCL has to remain low	180			ns
tSOSU	Time SO(SDA Read Mode) will be stable before the next rising edge of SCL		50		ns
tSOHLD	Time SO (SDA Read Mode) will remain stable after the falling edge of SCL		0	·	ns

Note: All timings are based on 20% to 80% of VDDIO-VSS

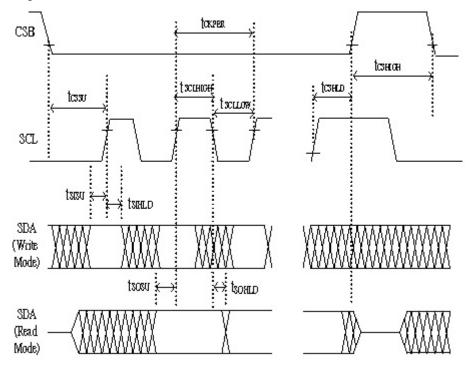


Figure 10-1: Serial peripheral interface characteristics



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#### 11. Power ON /OFF Sequence

In order to prevent IC fail in power on resetting, the power sequence must be followed as below. **Power ON Sequence** 

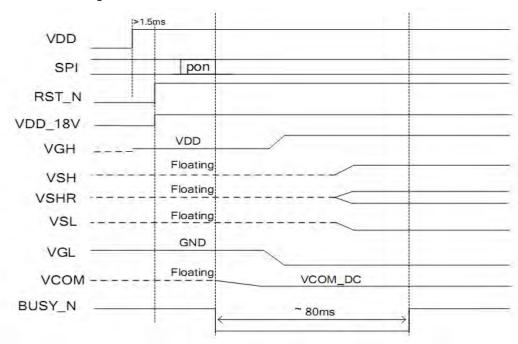


Figure 1: Power on sequence

#### **Power OFF Sequence**

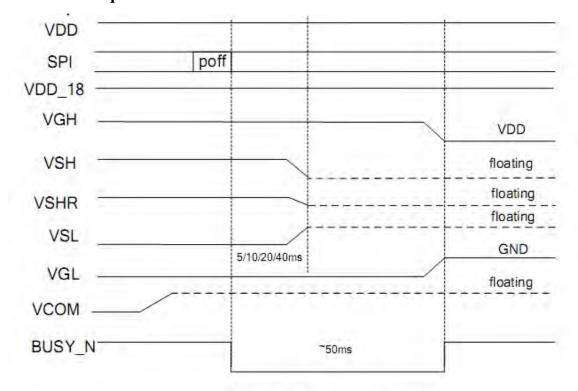
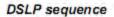


Figure 2: Power off sequence





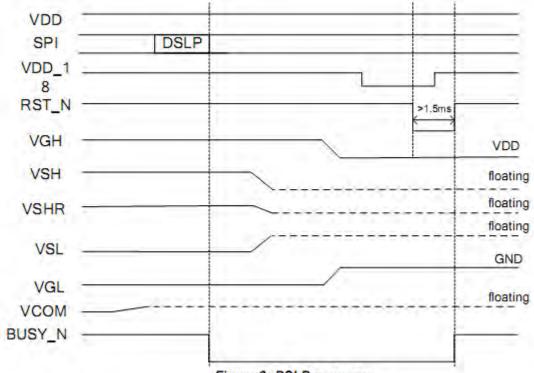


Figure 3: DSLP sequence

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#### 12. Power Consumption

Parameter	Symbol	Conditions	TYP	Max	Unit	Remark
Panel power consumption during update	-	25℃	8	-	mAs	-
Deep sleep mode	-	25℃	0.2	3	uA	-

mAs=update average current × update time

### 13. Optical characteristics

#### 13.1 Specifications

Measurements are made with that the illumination is under an angle of 45 degrees, the detection is perpendicular unless

otherwise specified.

T=25°C

SYMBOL	PARAMETER	CONDITIO NS	MIN	ТҮРЕ	MAX	UNIT	Note
R	Reflectance	White	30	35	-	%	Note 13-1
Gn	2Grey Level	-	-	$DS+(WS-DS)\times n(m-1)$	-	L*	-
CR	Contrast Ratio	indoor	-	10	-	-	-
Panel's life	-	0℃~30℃		5years		Note	13-2

WS: White state, DS: Dark state

Note 13-1: Luminance meter: Eye - One Pro Spectrophotometer;

Note 13-2: We guarantee display quality from  $0^{\circ}\text{C} \sim 30^{\circ}\text{C}$  generally, If operation ambient temperature from

 $0\sim50^{\circ}\text{C}$ , will Offer special waveform by Xingtai.

We don't guarantee 5 years pixels display quality for humidity below 45%RH or above 70%RH;

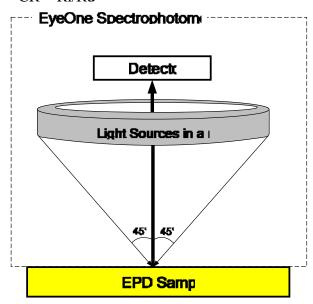
Suggest Updated once a day;



#### 13.2 Definition of contrast ratio

The contrast ratio (CR) is the ratio between the reflectance in a full white area (Rl) and the reflectance in a dark area (Rd):

CR = Rl/Rd



#### 13.3 Reflection Ratio

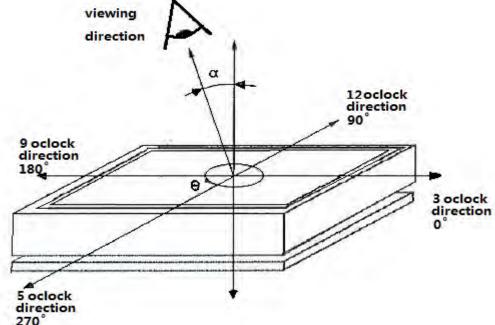
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The reflection ratio is expressed as:

 $R = Reflectance \ Factor \ _{white \ board} \qquad x \ (L \ _{center} \ / \ L \ _{white \ board})$ 

 $L_{center}$  is the luminance measured at center in a white area (R=G =B=1).  $L_{white\ board}$  is the luminance of a standard

board. Both are measured with equivalent illumination source. The viewing angle shall be no more than 2 degrees.



#### 14. HANDLING, SAFETY AND ENVIROMENTAL REQUIREMENTS

#### WARNING

The display glass may break when it is dropped or bumped on a hard surface. Handle with care. Should the display break, do not touch the electrophoretic material. In case of contact with electrophoretic material, wash with water and soap.

#### **CAUTION**

The display module should not be exposed to harmful gases, such as acid and alkali gases, which corrode electronic components.

Disassembling the display module can cause permanent damage and invalidate the warranty agreements.

IPA solvent can only be applied on active area and the back of a glass. For the rest part, it is not allowed.

Observe general precautions that are common to handling delicate electronic components. The glass can break and front surfaces can easily be damaged . Moreover the display is sensitive to static electricity and other rough environmental conditions.

#### **Mounting Precautions**

- (1) It's recommended that you consider the mounting structure so that uneven force (ex. Twisted stress) is not applied to the module.
- (2) It's recommended that you attach a transparent protective plate to the surface in order to protect the EPD. Transparent protective plate should have sufficient strength in order to resist external force.
- (3) You should adopt radiation structure to satisfy the temperature specification.
- (4) Acetic acid type and chlorine type materials for the cover case are not desirable because the former generates corrosive gas of attacking the PS at high temperature and the latter causes circuit break by electro-chemical reaction.
- (5) Do not touch, push or rub the exposed PS with glass, tweezers or anything harder than HB pencil lead. And please do not rub with dust clothes with chemical treatment. Do not touch the surface of PS for bare hand or greasy cloth. (Some cosmetics deteriorate the PS)
- (6) When the surface becomes dusty, please wipe gently with absorbent cotton or other soft materials like chamois soaks with petroleum benzene. Normal-hexane is recommended for cleaning the adhesives used to attach the PS. Do not use acetone, toluene and alcohol because they cause chemical damage to the PS.
- (7) Wipe off saliva or water drops as soon as possible. Their long time contact with PS causes deformations and color fading.

Product specification The data sheet contains final product specifications.

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**ROHS** 

# E-Paper Display Datasheet

ER-EPD027-2

#### **Limiting values**

Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

#### **Application information**

Where application information is given, it is advisory and dose not form part of the specification.

# Product Environmental certification

#### **REMARK**

All The specifications listed in this document are guaranteed for module only. Post-assembled operation or component(s) may impact module performance or cause unexpected effect or damage and therefore listed specifications is not warranted after any Post-assembled operation.

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### 15. Reliability test

	TEST	CONDITION	METHOD	REMARK
1	High-Temperature Operation	T=50°C RH=30%RH, For 240Hr	IEC 60 068-2-2Bb	
2	Low-Temperature Operation	$T = 0^{\circ}C$ for 240 hrs	IEC 60 068-2-2Ab	
3	High-Temperature Storage	T=70°C RH=40%RH For 240Hr Test in white pattern	IEC 60 068-2-2Bb	
4	Low-Temperature Storage	T = -25°C for 240 hrs Test in white pattern	IEC 60 068-2-2Ab	
5	High Temperature, High- Humidity Operation	T=40°C, RH=90%RH, For 168Hr	IEC 60 068-2-3CA	
6	High Temperature, High- Humidity Storage	T=60°C, RH=80%RH, For 240Hr Test in white pattern	IEC 60 068-2-3CA	
7	Temperature Cycle	-25 °C (30min)~70 °C (30min) , 100 Cycle Test in white pattern	IEC 60 068-2-14NB	
8	Package Vibration	1.04G,Frequency: 10~500Hz Direction: X,Y,Z Duration:1hours in each direction	Full packed for shipment	
9	Package Drop Impact	Drop from height of 122 cm on Concrete surface Drop sequence:1 corner, 3edges, 6face One drop for each.	Full packed for shipment	
10	UV exposure Resistance	765 W/m² for 168hrs,40°C	IEC 60068-2-5 Sa	
11	Electrostatic discharge	Machine model: $+/-250V,0\Omega,200pF$	IEC61000-4-2	

Actual EMC level to be measured on customer application.

Note1: Stay white pattern for storage and non-operation test.

Note2: Operation is black/white/red pattern, hold time is 150S.

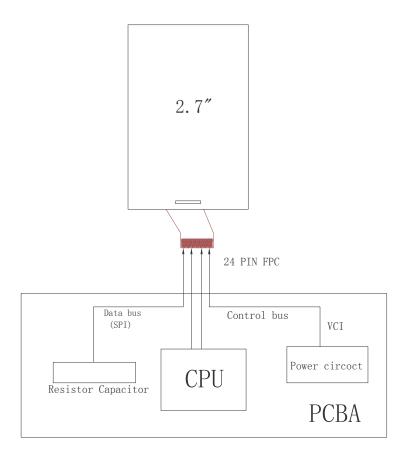
Note3: The function, appearence, opticals should meet the requirements of the test before and after the test.

Note4: Keep testing after 2 hours placing at  $20^{\circ}\text{C}-25^{\circ}\text{C}$ .

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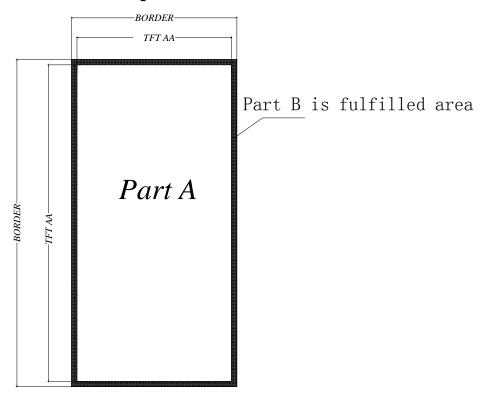


# 16. Block Diagram





# 17. PartA/PartB specification



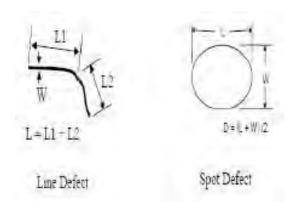


18. Point and line standard

URL: www.buydisplay.com

	Ship	ment Inspect	ion Standard				
	Equipm	ent: Electrical test	fixture, Point gau	ge			
Outline dimension	29.2(H)×59.2 (V) ×1.05(D)	Unit: mm	Part-A	Active area	Active area Part-B		
	Temperature	Humidity	Illuminance	Distance	Time	Angle	
Environment	19℃~25℃	55% ±5% RH	800~1300Lux	300 mm	35Sec		
Defet type	Inspection method	Standard		Part-A	A	Part-B	
		D≤0	.25 mm	Ignor	e	Ignore	
Spot	Electric Display	0.25 mm <	D≤0.4 mm	N≤4	1	Ignore	
		D>0	).4 mm	Not Allow		Ignore	
Display unwork	Electric Display	Not A	Allow	Not Allow		Ignore	
Display error	Electric Display	Not A	Allow	Not Allow		Ignore	
		L≤2 mm, W≤0.2 mm		Ignore		Ignore	
Scratch or line defect(include dirt)	Visual/Film card	2.0mm <l≤5.0mm, 0.2<w≤<br="">0.3mm,</l≤5.0mm,>		N≤2		Ignore	
		L>5 mm, W>0.3 mm		Not Allow		Ignore	
		D≤0	≤0.2mm Ignore		e	Ignore	
PS Bubble	Visual/Film card	0.2mm≤D≤0	.35mm & N≤4	N≤4	1	Ignore	
		D>0.35 mm		Not Allow		Ignore	
Corner /Edge chipping	Visual/Film card	$X \leqslant 6mm$ , $Y \leqslant 0.4mm$ , Do not affect the electrode circuit (Edge chipping) $X \leqslant 1mm$ , $Y \leqslant 1mm$ , Do not affect the electrode circuit (Corner chipping) Ignore					
D am - :1-	1.Cannot be defect & failure cause by appearance defect;						
Remark	2.Cannot be larger size cause by appearance defect;						
	L=long W=wide D=point size N=Defects NO						





L=long W=wide D=point size

#### 19. INSPECTION CRITERIA

#### 19.1 Acceptable Quality Level

Each lot should satisfy the quality level defined as follows

Partition	AQL	Definition
A. Major	0.4%	Functional defective as product
B. Minor	1.5%	Satisfy all functions as product but not satisfy cosmetic standard

#### 19.2 Definition of Lot

One lot means the delivery quantity to customer at one time.

#### 19.3 Condition of Cosmetic Inspection

- INSPECTION AND TEST
- -FUNCTION TEST
- -APPEARANCE INSPECTION
- -PACKING SPECIFICTION

#### INSPECTION CONDITION

- Put under the lamp (20W) at a distance 100mm from
- Tilt upright 45 degree by the front (back) to inspect LCD appearance.
- AQL INSPECTION LEVEL
- SAMPLING METHOD: MIL-STD-105D
- SAMPLING PLAN: SINGLE
- MAJOR DEFECT: 0.4% (MAJOR)MINOR DEFECT: 1.5% (MINOR)GENERAL LEVEL: II/NORMAL

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#### 19.4 Module Cosmetic Criteria

No.	Item	Judgment Criterion	Partition
1	Difference in Spec.	None allowed	Major
2	Pattern Peeling	No substrate pattern peeling and floating	Major
3	Soldering Defects	No soldering missing	Major
		No soldering bridge	Major
		No cold soldering	Minor
4	Resist Flaw on Substrate	Invisible copper foil( ¢ 0.5mm or more)on substrate pattern	Minor
5	Accretion of Metallic	No soldering dust	Minor
	Foreign Matter	No accretion of metallic foreign matters(Not exceed ¢ 0.2mm)	
6	Stain	No stain to spoil cosmetic badly	Minor
7	Plate Discoloring	No plate fading, rusting and discoloring	Minor
8	Solder Amount  1.Lead Parts	a. Soldering side of PCB  Solder to form a' Filet' all around t  Solder should not hide the lead form  b.Components side  (In case of 'Through Hole PCB')  Solder to reach the Components  side of PCB	Minor
	2.Flat Packages  3.Chips	Either 'toe' (A) or 'heal' (B) of the lead to be covered by Filet'  Lead form to be assume over solder.  (3/2) H≥h≥(1/2)H	Minor



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9	Backlight Defects	1.Light fails or flickers.(Major)	
		2. Color and luminance do not correspond to specifications.	See
		(Major)	list
		3.Exceeds standards for display's blemishes, foreign matter,	←
		dark lines or scratches.(Minor)	
10	PCB Defects	Oxidation or contamination on connectors.*	
		2. Wrong parts, missing parts, or parts not in specification.*	
		3.Jumpers set incorrectly.(Minor)	See
		4.Solder(if any)on bezel, LED pad, zebra pad, or screw hole	list
		pad is not smooth.(Minor)	←
		*Minor if display functions correctly. Major if the display fails.	
11	Soldering Defects	1. Unmelted solder paste.	Minor
		2. Cold solder joints, missing solder connections, or oxidation.*	
		3. Solder bridges causing short circuits.*	
		4. Residue or solder balls.	
		5. Solder flux is black or brown.	
		*Minor if display functions correctly. Major if the display fails.	

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#### 19.5 Screen Cosmetic Criteria (Non-Operating)

No.	Defect	Judgment Criterion	Judgment Criterion		
1	Spots	In accordance with Screen Cosmetic C	Criteria (Operating) No.1.	Minor	
2	Lines	In accordance with Screen Cosmetic C	Criteria (Operation) No.2.	Minor	
3	Bubbles in Polarizer			Minor	
		Size: d mm	Acceptable Qty in active area		
		d≦0.3	Disregard		
		0.3 <d≦1.0< td=""><td>3</td><td></td></d≦1.0<>	3		
		1.0 < d≦1.5	1		
		1.5 <d< td=""><td>0</td><td></td></d<>	0		
4	Scratch	In accordance with spots and lines op	erating cosmetic criteria, When the light	Minor	
		reflects on the panel surface, the scra	tches are not to be remarkable.		
5	Allowable density	Above defects should be separated m	Above defects should be separated more than 30mm each other.		
6	Coloration	Not to be noticeable coloration in the	Minor		
		Back-lit type should be judged with b			
7	Contamination	Not to be noticeable.		Minor	

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#### 19.6 Screen Cosmetic Criteria (Operating)

No.	Defect	Judgme	nt Criterion	Partition
1	Spots	A) Clear		Minor
		Size:d mm	Acceptable Qty in active area	
		d≦0.1	Disregard	
		0.1 <d≤0.2< td=""><td>6</td><td></td></d≤0.2<>	6	
		0.2 <d<u>≤0.3</d<u>	2	
		0.3 <d< td=""><td>0</td><td></td></d<>	0	
		Note: Including pin holes and defective dots which must be within one pixel		
		Size.		
		Unclear		
		Size:d mm	Acceptable Qty in active area	
		d≦0.2	Disregard	
		0.2 <d≦0.5< td=""><td>6</td><td></td></d≦0.5<>	6	
		0.5 <d<u>≤0.7</d<u>	2	
		0.7 <d< td=""><td>0</td><td></td></d<>	0	
2	Lines	A) Clear		Minor
		L 5.0 2.0  (6)  0.02 0.05  Note: () – Acceptable Qty in active area L - Length (mm) W -Width(mm)  ∞-Disregard B) Unclear  L 10.0  2.0  (6)  (6)	See No.1  0.1  See No.1  See No.1  0.3  See No.1	

Clear' = The shade and size are not changed by Vo.

Unclear' = The shade and size are changed by Vo.

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No.	Defect	Judgment Criterion	Partition
3	Rubbing line	Not to be noticeable.	Minor
4	Allowable density	Above defects should be separated more than 10mm each other.	Minor
5	Rainbow	Not to be noticeable.	Minor
6	Dot size	Pot size To be 95%~105% of the dot size (Typ.) in drawing.	
		Partial defects of each dot (ex.pin-hole) should be treated as spot.	
		(see Screen Cosmetic Criteria (Operating) No.1)	
7	Brightness	Brightness Uniformity must be BMAX/BMIN≦2	Minor
	(only back-lit	- BMAX : Max.value by measure in 5 points	
	Module)	- BMIN : Min.value by measure in 5 points	
		Divide active area into 4 vertically and horizontally.	
		Measure 5 points shown in the following figure.	
8	Contrast	Contrast Uniformity must be BmAX/BMIN≦2	Minor
	Uniformity		
	Dashed lines divide active area into 4 vertically and horizontally.		
		Measuring points are located at the inter-sections of dashed line.  Note: BMAX – Max.value by measure in 5 points.  BMIN – Min.value by measure in 5 points.  O – Measuring points in ¢ 10mm.	

#### Note:

- (1) Size: d=(long length + short length)/2
- (2) The limit samples for each item have priority.
- (3) Complexed defects are defined item by item, but if the number of defects is defined in above table, the total number should not exceed 10.
- (4) In case of 'concentration', even the spots or the lines of 'disregarded' size should not be allowed. Following three situations should be treated as 'concentration'.
  - -7 or over defects in circle of ¢5mm.
  - -10 or over defects in circle of ¢10mm
  - -20 or over defects in circle of ¢20mm

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#### 20. PRECAUTIONS FOR USING

#### 20.1 Handling Precautions

- This device is susceptible to Electro-Static Discharge (ESD) damage. Observe Anti-Static precautions.
- EastRising display panel is made of glass. Do not subject it to a mechanical shock by dropping it or impact.
- If EastRising display panel is damaged and the liquid crystal substance leaks out, be sure not to get any in your mouth. If the substance contacts your skin or clothes, wash it off using soap and water.
- Do not apply excessive force to the EastRising display surface or the adjoining areas since this may cause the color tone to vary.
- The polarizer covering the EastRising display surface of the LCD module is soft and easily scratched. Handle this polarizer carefully.
- If EastRising display surface becomes contaminated, breathe on the surface and gently wipe it with a soft dry cloth. If it is heavily contaminated, moisten cloth with one of the following Isopropyl or alcohol.
- Solvents other than those above-mentioned may damage the polarizer. Especially, do not use the Water.
- Exercise care to minimize corrosion of the electrode. Corrosion of the electrodes is accelerated by water droplets, moisture condensation or a current flow in a high-humidity environment.
- Install the EastRising LCD Module by using the mounting holes. When mounting the LCD module make sure it is free of twisting, warping and distortion. In particular, do not forcibly pull or bend the cable or the backlight cable.
- Do not attempt to disassemble or process EastRising LCD module.
- NC terminal should be open. Do not connect anything.
- If the logic circuit power is off, do not apply the input signals.
- To prevent destruction of the elements by static electricity, be careful to maintain an optimum work environment.
  - -Be sure to ground the body when handling EastRising LCD modules.
  - -Tools required for assembling, such as soldering irons, must be properly grounded.
- -To reduce the amount of static electricity generated, do not conduct assembling and other work under dry conditions.
- -The LCD module is coated with a film to protect the display surface. Exercise care when peeling off this protective film since static electricity may be generated.

#### 20.2 Power Supply Precautions

- Identify and, at all times, observe absolute maximum ratings for both logic and LC drivers. Note that there is some variance between models.
- Prevent the application of reverse polarity to VDD and VSS, however briefly.
- Use a clean power source free from transients. Power-up conditions are occasionally jolting and may exceed the maximum ratings of EastRising modules.
- The VDD power of EastRising module should also supply the power to all devices that may access the display. Don't allow the data bus to be driven when the logic supply to the module is turned off.

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#### 20.3 Operating Precautions

- DO NOT plug or unplug EastRising module when the system is powered up.
- Minimize the cable length between EastRising module and host MPU.
- For models with backlights, do not disable the backlight by interrupting the HV line. Unload inverters produce voltage extremes that may arc within a cable or at the display.
- Operate EastRising module within the limits of the modules temperature specifications.

#### 20.4 Mechanical/Environmental Precautions

- Improper soldering is the major cause of module difficulty. Use of flux cleaner is not recommended as they may seep under the electrometric connection and cause display failure.
- Mount EastRising module so that it is free from torque and mechanical stress.
- Surface of the LCD panel should not be touched or scratched. The display front surface is an easily scratched, plastic polarizer. Avoid contact and clean only when necessary with soft, absorbent cotton dampened with petroleum benzene.
- Always employ anti-static procedure while handling EastRising module.
- Prevent moisture build-up upon the module and observe the environmental constraints for storage tem
- Do not store in direct sunlight
- If leakage of the liquid crystal material should occur, avoid contact with this material, particularly ingestion. If the body or clothing becomes contaminated by the liquid crystal material, wash thoroughly with water and soap.

#### 20.5 Storage Precautions

When storing the LCD modules, avoid exposure to direct sunlight or to the light of fluorescent lamps.

Keep EastRising modules in bags (avoid high temperature / high humidity and low temperatures below 0 °C.

Whenever possible, EastRising LCD modules should be stored in the same conditions in which they were shipped from our company.

#### 20.6 Others

Liquid crystals solidify under low temperature (below the storage temperature range) leading to defective orientation or the generation of air bubbles (black or white). Air bubbles may also be generated if the module is subject to a low temperature. If EastRising LCD modules have been operating for a long time showing the same display patterns, the display patterns may remain on the screen as ghost images and a slight contrast irregularity may also appear. A normal operating status can be regained by suspending use for some time. It should be noted that this phenomenon does not adversely affect performance reliability.

To minimize the performance degradation of the LCD modules resulting from destruction caused by static electricity etc., exercise care to avoid holding the following sections when handling the modules.

- -Exposed area of the printed circuit board.
- -Terminal electrode sections.

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#### 21. USING LCD MODULES

#### 21.1 Liquid Crystal Display Modules

EastRising LCD is composed of glass and polarizer. Pay attention to the following items when handling.

- Please keep the temperature within specified range for use and storage. Polarization degradation, bubble generation or polarizer peel-off may occur with high temperature and high humidity.
- Do not touch, push or rub the exposed polarizers with anything harder than an HB pencil lead (glass, tweezers, etc.).
- N-hexane is recommended for cleaning the adhesives used to attach front/rear polarizers and reflectors made of organic substances which will be damaged by chemicals such as acetone, toluene, ethanol and isopropyl alcohol.
- When EastRising display surface becomes dusty, wipe gently with absorbent cotton or other soft material like chamois soaked in petroleum benzin. Do not scrub hard to avoid damaging the display surface.
- Wipe off saliva or water drops immediately, contact with water over a long period of time may cause deformation or color fading.
- Avoid contacting oil and fats.
- Condensation on the surface and contact with terminals due to cold will damage, stain or dirty the polarizers. After products are tested at low temperature they must be warmed up in a container before coming is contacting with room temperature air.
- Do not put or attach anything on EastRising display area to avoid leaving marks on.
- Do not touch the display with bare hands. This will stain the display area and degradate insulation between terminals (some cosmetics are determinated to the polarizers).
- As glass is fragile. It tends to become or chipped during handling especially on the edges. Please avoid dropping.

#### 21.2 Installing LCD Modules

- Cover the surface with a transparent protective plate to protect the polarizer and LC cell.
- When assembling the LCM into other equipment, the spacer to the bit between the LCM and the fitting
  plate should have enough height to avoid causing stress to the module surface, refer to the individual specifications for
  measurements. The measurement tolerance should be±0.1mm.

#### 21.3 Precaution for Handling LCD Modules

Since EastRising LCM has been assembled and adjusted with a high degree of precision; avoid applying excessive shocks to the module or making any alterations or modifications to it.

- Do not alter, modify or change the shape of the tab on the metal frame.
- Do not make extra holes on the printed circuit board, modify its shape or change the positions of components to be attached.
- Do not damage or modify the pattern writing on the printed circuit board.
- Absolutely do not modify the zebra rubber strip (conductive rubber) or heat seal connector.
- Except for soldering the interface, do not make any alterations or modifications with a soldering iron.
- Do not drop, bend or twist EastRising LCM.

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#### 21.4 Electro-Static Discharge Control

Since this module uses a CMOS LSI, the same careful attention should be paid to electrostatic discharge as for an ordinary CMOS IC.

- Make certain that you are grounded when handing LCM.
- Before remove LCM from its packing case or incorporating it into a set, be sure the module and your body have the same electric potential.
- When soldering the terminal of LCM, make certain the AC power source for the soldering iron does not leak.
- When using an electric screwdriver to attach LCM, the screwdriver should be of ground potentiality to minimize as much as possible any transmission of electromagnetic waves produced sparks coming from the commutator of the motor.
- As far as possible make the electric potential of your work clothes and that of the work bench the ground potential.
- To reduce the generation of static electricity be careful that the air in the work is not too dried. A relative humidity of 50%-60% is recommended.

#### 21.5 Precaution for Soldering to EastRising LCM

- Observe the following when soldering lead wire, connector cable and etc. to the LCM.
  - -Soldering iron temperature: 280°C±10°C
  - -Soldering time: 3-4 sec.
  - -Solder: eutectic solder.

If soldering flux is used, be sure to remove any remaining flux after finishing to soldering operation. (This does not apply in the case of a non-halogen type of flux.) It is recommended that you protect the LCD surface with a cover during soldering to prevent any damage due to flux spatters.

- When soldering the electroluminescent panel and PC board, the panel and board should not be detached more than three times. This maximum number is determined by the temperature and time conditions mentioned above, though there may be some variance depending on the temperature of the soldering iron.
- When remove the electroluminescent panel from the PC board, be sure the solder has completely melted, the soldered pad on the PCs board could be damaged.

#### 21.6 Precaution for Operation

- Driving the EastRising LCD in the voltage above the limit shortens its life.
- Response time is greatly delayed at temperature below the operating temperature range. However, this does not mean the LCD will be out of the order. It will recover when it returns to the specified temperature range.
- If EastRising display area is pushed hard during operation, the display will become abnormal. However, it will return to normal if it is turned off and then back on.
- Condensation on terminals can cause an electrochemical reaction disrupting the terminal circuit. Therefore, it must be used under the relative condition of 40°C, 50% RH.
- When turning the power on, input each signal after the positive/negative voltage becomes stable.

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#### 21.7 Limited Warranty

Unless agreed between EastRising and customer, EastRising will replace or repair any of its LCD modules which are found to be functionally defective when inspected in accordance with EastRising LCD acceptance standards (copies available upon request) for a period of one year from date of shipments. Cosmetic/visual defects must be returned to EastRising within 90 days of shipment. Confirmation of such date shall be based on freight documents. The warranty liability of EastRising limited to repair and/or replacement on the terms set forth above. EastRising will not be responsible for any subsequent or consequential events.

#### 21.8 Return Policy

No warranty can be granted if the precautions stated above have been disregarded. The typical examples of violations are:

- -Broken LCD glass.
- -PCB eyelet damaged or modified.
- -PCB conductors damaged.
- -Circuit modified in any way, including addition of components.
- -PCB tampered with by grinding, engraving or painting varnish.
- -Soldering to or modifying the bezel in any manner.

Module repairs will be invoiced to the customer upon mutual agreement. Modules must be returned with sufficient description of the failures or defects. Any connectors or cable installed by the customer must be removed completely without damaging the PCB eyelet's, conductors and terminals.

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#### 22. IMAGE STICKING

#### 22.1 What is Image Sticking?

If you remain a fixed image on LCD Display for a long period of time, you may experience a phenomenon called Image Sticking. Image Sticking - sometimes also called "image retention" or "ghosting" - is a phenomenon where a faint outline of a previously displayed image remains visible on the screen when the image is changed. It can occur at variable levels of intensity depending on the specific image makeup, as well as the amount of time the core image elements are allowed to remain unchanged on the screen.

#### 22.2 What Causes Image Sticking and How to Avoid?

1. The e-Paper display cannot be powered on for a long time, you must set e-Paper display to sleep mode or power off when it needn't refresh ,otherwise e-Paper keeps in high voltage status for long time which will damage e-Paper and cannot be fixed. We suggest customers to update e-Paper display every 24 hours or at least 10 days to update again. Otherwise, ghost of the last content may cannot be cleared.

It is also recommended that customer ships or stores the e-Paper display with completely white image to avoid image sticking issue and refresh

- 2. Three-color e-Paper display is normal to be a little "color" . You can refresh it to white to keep it upward for storage.
- 3. The e-Paper display ignores the data sent when it is in sleep mode, you need to initialize it for properly refreshing. The e-Paper display cannot refresh directly under sunlight. The refresh steps should be done indoor.
- 4. For those e-Paper displays which support partial refresh, you cannot use partial refresh all the time. A full refresh should be done to clear screen after several times (partial refresh), otherwise, e-Paper display will be damaged and cannot fixed.

#### 23. STORAGE

We recommend customers to refresh three-color e-Paper displays one by one if storage period is more than half a year, otherwise the image on display may be unclear as below image shows.

